



NEXCOM International Co., Ltd.

Mobile Computing Solutions
Vehicle Telematics Computer
VTC 6110
User Manual

CONTENTS

Preface

Copyright	iv
Disclaimer	iv
Acknowledgements	iv
Regulatory Compliance Statements	iv
Declaration of Conformity	iv
RoHS Compliance	v
Warranty and RMA	vi
Safety Information	vii
Installation Recommendations	vii
Safety Precautions	viii
Technical Support and Assistance	ix
Conventions Used in this Manual	ix
Global Service Contact Information	x
Package Contents	xii
Ordering Information	xiv

Chapter 1: Product Introduction

Overview	1
Key Features	2
Hardware Specifications	2
COM Express CPU Module and Carrier Board	5
Physical Features	6
Front Panel	6
Rear Panel	8
Mechanical Dimensions	12

Chapter 2: Jumpers And Connectors

Before You Begin	13
Precautions	13
Jumper	14
Locations of the Jumpers and Connectors	15
VTCB6110	15
Jumper Settings	16
SW5: Input Voltage Selection	16
SW6: COM Port Mode Selection	16
CF (IDE0) Primary Master/Slave Select (JP4)	16
LVDS Power Input Voltage Select (JP9)	16
CMOS Input Voltage Select (J6)	16
BIOS Function Select (J1)	16
DC Input Voltage Select (JP1)	16
Temp Sensor (JP8)	17
Auto Power Select (JP2)	17
PCI-104 V/I/O Select Voltage (J13)	17
MCU Download (JP6)	17
GAL Download (JP5)	17
MCU COM Port (JP3)	17
Connectors	18
COM Express Row A and Row B	18
COM Express Row C and Row D	20
CompactFlash Connector	22
GPIO Connector	23
RS232 Connector: COM1, COM2	23



RS232/485 Connector: COM3	24
GAL Programmer PIN Header	24
MCU Programmer Pin Header	25
VGA Connector	25
LVDS Connector + USB0	26
LAN Connector	27
USB Connector USB 1	27
USB Connector USB 2	28
LVDS Power Connector	28
External 12V & 5V Power and SMBUS Connector	29
Mic-in	29
Line-out	30
PCI-104 V/I/O Voltage Setting	30
PCI-104 Connector	31
Power Button	31
Reset Button	31
MCU COM Port	32
ACC_ON LED	32
Temp Sensor	33
DC Power Input Connector	33
Power On and IDE Active LED	34
GPIO and UMTS LEDs	34
Serial ATA	35
Serial ATA Power Input	35
Mini-PCIe Socket (for 3.5G module) PCIe Interface	36
Mini-PCIe Socket (for WLAN module) USB + PCIe Interface	36
SIM Card Connector	37
Bluetooth Connector	37

Chapter 3: System Setup

Removing the Chassis Cover	38
Installing a GPRS/UMTS/HSDPA Module	39
Installing a Wireless LAN Module	42

Installing a Bluetooth Module	45
Installing a CompactFlash Card	47
Installing the PCI-104 Module	49
Installing a SATA Hard Drive	51
Installing the SODIMM	55
Installing the USB Cable Holder	57
Rackmount Brackets	58

Appendix A: I/O Address Function

I/O Address Function	59
----------------------------	----

Appendix B: ICES200-L24 COM Express CPU Module

Overview	62
Key Features	62
Specifications	62
Mechanical Dimensions	65
PCI Routing	66
Connectors	67

Appendix C: VTCB6110 Carrier Board

Specifications	72
Jumpers and Connectors	73
Jumper Settings	74
Connectors	76

Appendix D: Vehicle Power Management Setup

Vehicle Power Management Setup	96
--------------------------------------	----

Appendix E: Power Consumption

Power Consumption	103
-------------------------	-----

PREFACE

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Acknowledgements

VTC 6110 is a trademark of NEXCOM International Co., Ltd. All other product names mentioned herein are registered trademarks of their respective owners.

Regulatory Compliance Statements

This section provides the FCC compliance statement for Class B devices and describes how to keep the system CE compliant.

Declaration of Conformity

FCC

This equipment has been tested and verified to comply with the limits for a Class B digital device, pursuant to Part 15 of FCC Rules. These limits are designed to provide reasonable protection against harmful interference when the equipment is operated in a commercial environment. This equipment generates, uses, and can radiate radio frequency energy and, if not installed and used in accordance with the instructions, may cause harmful interference to radio communications. Operation of this equipment in a residential area (domestic environment) is likely to cause harmful interference, in which case the user will be required to correct the interference (take adequate measures) at their own expense.

CE

The product(s) described in this manual complies with all applicable European Union (CE) directives if it has a CE marking. For computer systems to remain CE compliant, only CE-compliant parts may be used. Maintaining CE compliance also requires proper cable and cabling techniques.

e13 Mark

The “e” mark is the proof of compliance with directives (laws) required by the European Union. The Council of European communities in Brussels issues these directives and all members must accept approved products.

e13 - Luxembourg

For more information, visit http://www.tuv.com/jp/en/_e_mark_and_e_mark_homologation_for_vehicles_vehicle_components_.html.

RoHS Compliance



NEXCOM RoHS Environmental Policy and Status Update

NEXCOM is a global citizen for building the digital infrastructure. We are committed to providing green products and services, which are compliant with European Union

RoHS (Restriction on Use of Hazardous Substance in Electronic Equipment) directive 2002/95/EU, to be your trusted green partner and to protect our environment.

RoHS restricts the use of Lead (Pb) < 0.1% or 1,000ppm, Mercury (Hg) < 0.1% or 1,000ppm, Cadmium (Cd) < 0.01% or 100ppm, Hexavalent Chromium (Cr6+) < 0.1% or 1,000ppm, Polybrominated biphenyls (PBB) < 0.1% or 1,000ppm, and Polybrominated diphenyl Ethers (PBDE) < 0.1% or 1,000ppm.

In order to meet the RoHS compliant directives, NEXCOM has established an engineering and manufacturing task force in to implement the introduction of green products. The task force will ensure that we follow the standard NEXCOM development procedure and that all the new RoHS components and new manufacturing processes maintain the highest industry quality levels for which NEXCOM are renowned.

How to recognize NEXCOM RoHS Products?

For existing products where there are non-RoHS and RoHS versions, the suffix “(LF)” will be added to the compliant product name.

All new product models launched after January 2006 will be RoHS compliant. They will use the usual NEXCOM naming convention.

Warranty and RMA

NEXCOM Warranty Period

NEXCOM manufactures products that are new or equivalent to new in accordance with industry standard. NEXCOM warrants that products will be free from defect in material and workmanship for 2 years, beginning on the date of invoice by NEXCOM. HCP series products (Blade Server) which are manufactured by NEXCOM are covered by a three year warranty period.

NEXCOM Return Merchandise Authorization (RMA)

- ✘ Customers shall enclose the “NEXCOM RMA Service Form” with the returned packages.
- ✘ Customers must collect all the information about the problems encountered and note anything abnormal or, print out any on-screen messages, and describe the problems on the “NEXCOM RMA Service Form” for the RMA number apply process.
- ✘ Customers can send back the faulty products with or without accessories (manuals, cable, etc.) and any components from the card, such as CPU and RAM. If the components were suspected as part of the problems, please note clearly which components are included. Otherwise, NEXCOM is not responsible for the devices/parts.
- ✘ Customers are responsible for the safe packaging of defective products, making sure it is durable enough to be resistant against further damage and deterioration during transportation. In case of damages occurred during transportation, the repair is treated as “Out of Warranty.”

- ✘ Any products returned by NEXCOM to other locations besides the customers’ site will bear an extra charge and will be billed to the customer.

Repair Service Charges for Out-of-Warranty Products

NEXCOM will charge for out-of-warranty products in two categories, one is basic diagnostic fee and another is component (product) fee.

System Level

- ✘ Component fee: NEXCOM will only charge for main components such as SMD chip, BGA chip, etc. Passive components will be repaired for free, ex: resistor, capacitor.
- ✘ Items will be replaced with NEXCOM products if the original one cannot be repaired. Ex: motherboard, power supply, etc.
- ✘ Replace with 3rd party products if needed.
- ✘ If RMA goods can not be repaired, NEXCOM will return it to the customer without any charge.

Board Level

- ✘ Component fee: NEXCOM will only charge for main components, such as SMD chip, BGA chip, etc. Passive components will be repaired for free, ex: resistors, capacitors.
- ✘ If RMA goods can not be repaired, NEXCOM will return it to the customer without any charge.

Warnings

Read and adhere to all warnings, cautions, and notices in this guide and the documentation supplied with the chassis, power supply, and accessory modules. If the instructions for the chassis and power supply are inconsistent with these instructions or the instructions for accessory modules, contact the supplier to find out how you can ensure that your computer meets safety and regulatory requirements.

Cautions

Electrostatic discharge (ESD) can damage system components. Do the described procedures only at an ESD workstation. If no such station is available, you can provide some ESD protection by wearing an antistatic wrist strap and attaching it to a metal part of the computer chassis.

Safety Information

Before installing and using the device, note the following precautions:

- Read all instructions carefully.
- Do not place the unit on an unstable surface, cart, or stand.
- Follow all warnings and cautions in this manual.
- When replacing parts, ensure that your service technician uses parts specified by the manufacturer.
- Avoid using the system near water, in direct sunlight, or near a heating device.
- The load of the system unit does not solely rely for support from the rackmounts located on the sides. Firm support from the bottom is highly necessary in order to provide balance stability.
- The computer is provided with a battery-powered real-time clock circuit. There is a danger of explosion if battery is incorrectly replaced. Replace only with the same or equivalent type recommended by the manufacturer. Discard used batteries according to the manufacturer's instructions.

Installation Recommendations

Ensure you have a stable, clean working environment. Dust and dirt can get into components and cause a malfunction. Use containers to keep small components separated.

Adequate lighting and proper tools can prevent you from accidentally damaging the internal components. Most of the procedures that follow require only a few simple tools, including the following:

- A Philips screwdriver
- A flat-tipped screwdriver
- A grounding strap
- An anti-static pad

Using your fingers can disconnect most of the connections. It is recommended that you do not use needlenose pliers to disconnect connections as these can damage the soft metal or plastic parts of the connectors.

Safety Precautions

1. Read these safety instructions carefully.
2. Keep this User Manual for later reference.
3. Disconnect this equipment from any AC outlet before cleaning. Use a damp cloth. Do not use liquid or spray detergents for cleaning.
4. For plug-in equipment, the power outlet socket must be located near the equipment and must be easily accessible.
5. Keep this equipment away from humidity.
6. Put this equipment on a stable surface during installation. Dropping it or letting it fall may cause damage.
7. Do not leave this equipment in either an unconditioned environment or in a above 40°C storage temperature as this may damage the equipment.
8. The openings on the enclosure are for air convection to protect the equipment from overheating. DO NOT COVER THE OPENINGS.
9. Make sure the voltage of the power source is correct before connecting the equipment to the power outlet.
10. Place the power cord in a way so that people will not step on it. Do not place anything on top of the power cord. Use a power cord that has been approved for use with the product and that it matches the voltage and current marked on the product's electrical range label. The voltage and current rating of the cord must be greater than the voltage and current rating marked on the product.
11. All cautions and warnings on the equipment should be noted.
12. If the equipment is not used for a long time, disconnect it from the power source to avoid damage by transient overvoltage.
13. Never pour any liquid into an opening. This may cause fire or electrical shock.
14. Never open the equipment. For safety reasons, the equipment should be opened only by qualified service personnel.
15. If one of the following situations arises, get the equipment checked by service personnel:
 - a. The power cord or plug is damaged.
 - b. Liquid has penetrated into the equipment.
 - c. The equipment has been exposed to moisture.
 - d. The equipment does not work well, or you cannot get it to work according to the user's manual.
 - e. The equipment has been dropped and damaged.
 - f. The equipment has obvious signs of breakage.
16. Do not place heavy objects on the equipment.
17. The unit uses a three-wire ground cable which is equipped with a third pin to ground the unit and prevent electric shock. Do not defeat the purpose of this pin. If your outlet does not support this kind of plug, contact your electrician to replace your obsolete outlet.
18. CAUTION: DANGER OF EXPLOSION IF BATTERY IS INCORRECTLY REPLACED. REPLACE ONLY WITH THE SAME OR EQUIVALENT TYPE RECOMMENDED BY THE MANUFACTURER. DISCARD USED BATTERIES ACCORDING TO THE MANUFACTURER'S INSTRUCTIONS.
19. The computer is provided with CD drives that comply with the appropriate safety standards including IEC 60825.

Technical Support and Assistance

1. For the most updated information of NEXCOM products, visit NEXCOM's website at www.nexcom.com.
2. For technical issues that require contacting our technical support team or sales representative, please have the following information ready before calling:
 - Product name and serial number
 - Detailed information of the peripheral devices
 - Detailed information of the installed software (operating system, version, application software, etc.)
 - A complete description of the problem
 - The exact wordings of the error messages

Warning!

1. Handling the unit: carry the unit with both hands and handle it with care.
2. Maintenance: to keep the unit clean, use only approved cleaning products or clean with a dry cloth.
3. CompactFlash: Turn off the unit's power before inserting or removing a CompactFlash storage card.

Conventions Used in this Manual



Warning: Information about certain situations, which if not observed, can cause personal injury. This will prevent injury to yourself when performing a task.



Caution: Information to avoid damaging components or losing data.



Note: Provides additional information to complete a task easily.

Global Service Contact Information

Headquarters

Taiwan

18F, No. 716, Chung-Cheng Rd. Chung-Ho City,
Taipei County 235, Taiwan, R.O.C.
Tel: +886-2-8228-0606
Fax: +886-2-8228-0501
<http://www.nexcom.com.tw>

USA

3758 Spinnaker Court,
Fremont, CA 94538, USA
Tel: +1-510-656-2248
Fax: +1-510-656-2158
<http://www.nexcom.com>

France

Z.I. des Amandiers, 17, Rue des entrepreneurs
78420 Carrières sur Seine, France
Tel: +33 (0)1 71 51 10 20
Fax: +33 (0)1 71 51 10 21
<http://www.nexcom.eu>

Germany

Leopoldstrase Business Centre, Leopoldstrase 244 80807
Munich, Germany
Tel: +49-89-208039-278
Fax: +49-89-208039-279
<http://www.nexcom.eu>

Italy

Via Gaudenzio Ferrari 29, 21047 Saronno (VA) Italia
Tel: +39 02 9628 0333
Fax: +39 02 9619 8846
<http://www.nexcom.eu>

United Kingdom

10 Vincent Avenue, Crownhill Business Centre
Milton Keynes, Buckinghamshire, MK8 0AB
United Kingdom
Tel: +44-1908-267121
Fax: +44-1908-262042
<http://www.nexcom.eu>

China-Beijing

Room 301, Block E, Power Creative Building, No. 1
Shangdi East Rd. Haidian Dist., Beijing, 100085, China
Tel: +86-10-5885-6655
Fax: +86-10-5885-1066
<http://www.nexcom.cn>

China-Shanghai Office

Room 1505, Greenland He Chuang Building, No. 450
Caoyang Rd. Shanghai, 200063, China
Tel: +86-21-6150-8008
Fax: +86-21-3251-6358
<http://www.nexcom.cn>

China-Nanjing Office

Room 1206, Hongde Building, No. 20 Yunnan Rd.
Nanjing, 210018, China
Tel: +86-25-8324-9606
Fax: +86-25-8324-9685
<http://www.nexcom.cn>

China-Shenzhen Office

Western Room 708, Block 210, Tairan Industry & Trading Place,
Futian Area, Shenzhen, China 518040
TEL: +86-755-833 27203
FAX: +86-755-833 27213
<http://www.nexcom.cn>

Japan

10F, Nakagin-Shiroyama Building, 8-16-13.
Ginza Chuou-ku, Tokyo 104-0061, Japan
Tel: +81-3-3524-4250
Fax: +81-3-3524-4252
<http://www.nexcom-jp.com>

PACKAGE CONTENTS

Before continuing, verify that the VTC 6110 package that you received is complete. Your VTC 6110 package should have all the items listed in the following table.

Item	P/N	Name	Specification	Qty
1	4NCPM00302X00	POWER CON 3P PHOENIX CONTACT		1
2	5060100017X00	DAMPER	6mm/OUTSIDE DIA .12mm H: 9mm TPS(BLACK)	4
3	50311F0119X00	I HEAD BOLTS SCREW LONG	I3x12.5 AXISx 8.5mm SCREWx 4mm	4
4	60233PW134X00	(N)POWER CABLE FOR VTK33B SMBUS SIGNAL		1
5	60233ATA10X00	SATA CABLE	L: 70mm	1
6	60233PW102X00	SATA POWER CABLE	SATA 15PIN TO 3022H-04 4PIN PITCH 5.08mm ,L: 80mm	1
7	5042220027X00	(N)WIRE MOUNT	19.1x8.4x1.3 NYLON66	3
8	50311F0150X00	(N)F HEAD SCREW LONG	#6-32X8 NI NYLOK	3
9	60233SAM05X00	GPS ANTENNA	5M /SMA180P	1
10	50311F0100X00	ROUND HEAD SCREW W/SPRING+FLAT WASHER LONG	P3x6 iso/SW6x0.5 NI	4

Item	P/N	Name	Specification	Qty
11	5043330247X00	HDD BRACKET	129.5x97x 1mm	1
12	5043330246X00	HDD BRACKET FOR CUSHION LEFT	123.3x44.5x 14.7mm	1
13	5043330245X00	HDD BRACKET FOR CUSHION RIGHT	128.5x17x 1mm	1
14	50344C0067X00	COPPER POST LONG	WITH MALE/FEMALE (FEMALE)16mmx(MALE)5mmxM3	4
15	5060100012X00	HIGH-END DAMPER INSIDE	11.1mm H: 10.8mm TPS(BLACK)	4
16	50311F0107X00	I HEAD BOLTS SCREW LONG	I3x14 AXISx 10mm SCREWx 4mm (BLACK)	4
17	602DCD0256X00	CD driver		1

ORDERING INFORMATION

The following provides ordering information for VTC 6110.

- **VTC 6110 (P/N: 10V00611000X0)**
 - with Intel Core™ Duo L2400, 1GB DDR2 memory, GPS module and GPS antenna

CHAPTER 1: PRODUCT INTRODUCTION

Overview



Front View



Rear View

The VTC6110 is an innovative in-vehicle computer for use in any car, truck, or even for maritime applications. The design itself makes the system available as a complete system allowing the user to easily define and build requirements.

VTC6110 fulfills vehicle industry requirements. The design itself is in compliance with vehicle industrial standard such as eMark. More features required for in-vehicle operations, such as power ignition delay control, low-power protection and SMBus connection, etc., are continued from NEXCOM's other in-vehicle computer products.

The GPS function navigates drivers to ultimate the fleet management. Optional 802.11b/g/n, 3.5G, GPRS, and Bluetooth availability make VTC6110 ready for wider coverage and future trend. Multiple display connections make VTC6110 an ideal choice for in-vehicle signage platforms as well.

Key Features

- Built-in Intel® Core™ Duo LV processor
- Fanless design with ruggedized aluminum chassis
- 2 Mini PCI Express and 1 PCI-104 expansions
- Wide range DC input from 6V to 36V
- Power ignition on/off delay controlled by software
- Low battery power protection setting by software
- External smart battery back-up support
- S3 & S4 suspend mode support
- Availability of GPS, GPRS/UMTS/HSDPA
- Multiple display connections thru VGA, DVI-D and LVDS
- Optional IP65 enclosure
- e13 Mark certification

Hardware Specifications

COM Express CPU Module (ICES200-L24)

- Intel® Core™ Duo L2400
- VGA/PCI/PCle/LVDS/Audio/COM/LPT/USB2.0/LAN interface

Memory

- Supports DDR2 533/667 non-ECC, non-registered SDRAM
- One 200-pin SO-DIMM supports up to 2GB memory

Chipset

- Intel 945GME / ICH7M

Expansion

- 2 Mini PCI Express slots
 - 1 x (PCle + USB) for WLAN card
 - 1 x PCle for HSDPA module or GPRS module
- 1 PCI-104 slot
- 1 Bluetooth module (optional)

I/O Interfaces - Front

- Logo plate
- 1 x Power button (w/ LED)
- 1 x Reset button
- 1 x SIM card socket
- 1 x USB 2.0
- 1 x Power LED
- 1 x HDD LED
- 1 x GPIO LED - programmable for alarm or other application specific purposes
- 1x LED for COMM (WLAN/HSDPA) status
- Antenna mounting holes for 4x SMA-type (WLAN, HSDPA and Bluetooth)
- 1 x Line-out
- 1 x Mic-in

I/O Interfaces - Rear

- COM ports
 - 1 x DB9 COM1 RS232
 - 1 x DB9 COM2 RS232
 - 1 x DB9 COM3 RS232/485 w/ auto flow control
- 1 x DB26 LVDS (w/ +12V for backlight power and USB2.0)
- 1 x DB15 VGA
- 1 x DVI-D
- 2 x USB
- 1 x Realtek 10/100/1000 Ethernet
- 2 x Mic-in and 2 Line-out (ALC888-VC2-GR HD Codec, AC'97 Compatible)

- 6V (15A) to 36V (5A) thru DC 3-pin power input connector (ignition, power input and ground)
- 1 x DB9 Female for digital I/O with 4-input and 4-output
- +5 VDC (1A) and +12VDC (1A) power output and SMBus (w/o VTK 33M-01 connection)
+5 VDC (0.5A) and +12VDC (0.5A) power output and SMBus (w/ VTK 33M-01 connection)

Expandable Storage

- 1 x 2.5" SATA HDD drive bay
- 1 Type II CompactFlash socket (IDE)-

Construction

- Aluminum enclosure with fanless design

Protection Class

- IP65 compliant (w/ optional IP65 kit)

Certifications

- CE, FCC Class B, e13 Mark, EN50155

Dimensions

- 260mm(W) x 176mm(D) x 50mm(H) (10.24" x 7" x 1.97")

Environment

W/O Vibration Kit

- Operating Temperatures:
Ambient with air: -30°C to 50°C (CF/SSD); -30°C to 50°C (HDD)
- Storage temperature: -40°C to 80°C
- Relative humidity: 10% to 90% (Non-condensing)
- Vibration (random): 2g @ 5~500 Hz with CF/SSD; 1g @ 5~500 Hz with Automotive HDD (in operation)
- Vibration
Operating: MIL-STD-810F, Method 514.5, Category 20, Ground Vehicle – Highway Truck
C-17, 0.04 g2/Hz at 20-1000 Hz, -6 dB/Octave at 1000-2000 Hz
Tested MIL-STD-810F method 514.5
Storage: MIL-STD-810F, Method 514.5, Category 24, Integrity Test
Shock:
Operating: MIL-STD-810F, Method 516.5, Procedure I, Trucks and semi-trailers=20g
Crash Hazard: MIL-STD-810F, Method 516.5, Procedure V, Ground equipment = 75g

OS Support

- Vista, XP, XPe, Linux 2.6

Power Management

- Power-on delay time is selectable by BIOS to disable and enable in 10sec / 30sec / 1min / 5min / 10 min / 15min / 30min / 1hr.
- Power-off delay time is selectable by BIOS to disable and enable in 20sec / 1min / 5min / 10min / 30min / 1hr / 6hr / 18hr.
- S3, S4 suspend mode
- Ignition On/Off status detectable by SW
- Low battery status detectable by SW
- Ignition enable/disable is jumper selectable
- Shut down system automatically when the system's internal temperature is over 80C.
- VTC 6110 will automatically shut down 5 minutes after the duration of low battery voltage is over 60 sec. User can detect this situation via software.
- If the ignition is off and the system is still on after 3 minutes, VTC 6110 will shut down automatically.
- If the ignition is off, the user can detect this status via the software.
- If the ignition is turned on again and the power-off delay is in progress, VTC 6110 will cancel the delay function and will continue to operate normally.
- If the ignition is turned on again and the power-off delay ended, VTC 6110 will shut down completely will power-on again automatically.
- If the ignition is turned off again and power-on delay is in progress, VTC 6110 will cancel the delay and stay in power-off status.
- If the ignition is turned off again and the power-on delay ended (entered OS already), VTC 6110 will continue to operate normally.
- If the ignition is turned off again and the power-on delay ended (in BIOS process), VTC 6110 will shut down immediately.
- If VTC 6110 is off, only below 10mA is used.

COM Express CPU Module and Carrier Board

The VTC 6110 system uses the ICES200-L24 COM Express CPU module and the VTCB6110 carrier board.

ICES200-L24 COM Express CPU Module

ICES200-L24 is a COM Express CPU module that uses the Intel® 945GME chipset and supports Intel® Core™ Duo L2400.

The module also supports one unbuffered non-ECC 533/667 DDR2 SO-DIMM with maximum memory size up to 2GB. The Intel® 945GME chipset supports the following interfaces: PCI, PCIe, SATA, VGA, LVDS, LAN, Serial, USB, etc.

The ICES200-L24 module is based on the COM Express basic form factor Type 2 standard, x2 connections between the COM Express CPU module and the I/O carrier board.

The ICES200-L24 CPU module can easily integrate into most of the limited-space devices such as industrial automation, data acquisition and equipment computers.

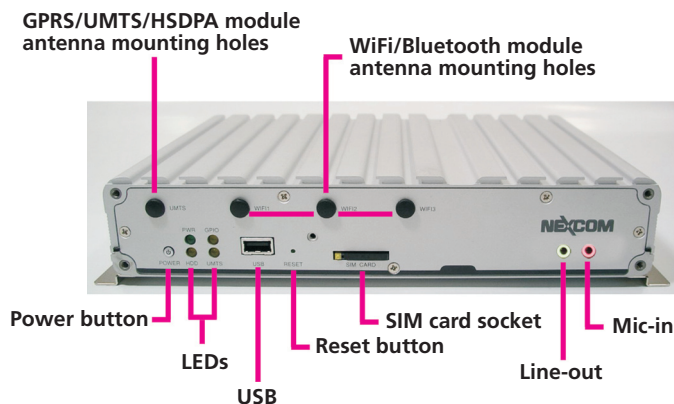
VTCB6110 Carrier Board

Key features:

- Quick customizable COM Express architecture platform
- Wide varieties of built-in communication and I/O ports specially designed for Transport Application
- Customizable delay time for power-on and power-off
- Three external serial port interfaces with two RS232 and one RS232/485
- Supports 10/100/1000 LAN, VGA Console, LVDS and GPIO
- 3 x USB 2.0 ports
- Supports PCI-104 expansion

Physical Features

Front Panel



Power Button

There are 4 types of power on/off mode. Use JP1 and JP2 to select a mode. (refer to the Internal Jumpers and Connectors section for details).

Vehicle PC Mode

1. Mode A (default setting). When the ignition is from “low” to “high”, VTC 6110 will turn on automatically. When the ignition is “high”, press the power button to turn on/off VTC 6110.

When the ignition is from “high” to “low”, VTC 6110 will turn off automatically. When the ignition is “low”, pressing the power button will not turn on VTC 6110.

2. Mode B. When the ignition is from “low” to “high”, you can turn on VTC 6110 only by pressing the power button. When the ignition is “high”, you can press the power button to turn on/off VTC 6110.

If the ignition is from “high” to “low”, VTC 6110 will turn off automatically. When the ignition is “low”, pressing the power button will not turn on VTC 6110.

Normal PC Mode

3. Mode C. When there is power input, you can turn on VTC 6110 only by pressing the power button. Ignition signal will not power on/off VTC 6110.
4. Mode D. When there is power input, VTC 6110 will turn on automatically. Ignition signal will not power on/off VTC 6110.

Startup and Shutdown Mode (Refer to SW5 setting)

The start up and shut down setting modes are as follows.

1. Mode A (default setting). When the input power voltage is 12V, use SW5 to select this voltage. Use the BIOS to select the start up and shut down voltages.
2. Mode B. When the input power voltage is 24V, use SW5 to select this voltage. Use the BIOS to select the start up and shut down voltages.
3. Mode C. The working input power voltage is 6V~36V. Start up and shut down voltages settings are disabled. When using external battery kit (VTK33B), mode C setting is required.

LEDs



GPIO	I/O PORT Address : <Read/Write> #0EE0H Bit 0 : 0(Off) 1(On).
COMM	WLAN/HSDPA Status

SIM Card Socket

VTC 6110 can be internally integrated with a 3.5G Mini Card module. The SIM card bracket is on the carrier board. When using the GPRS/UMTS/HSDPA function, insert the SIM card into the SIM card socket. Make sure to turn off VTC 6110 before inserting the SIM card.

USB Port

The USB port complies with USB 2.0 specifications.

WiFi/Bluetooth Module Antenna Mounting Holes

The 3 external antenna mounting holes are used to mount and connect WiFi antenna to a WLAN module (Mini Card type).

GPRS/UMTS/HSDPA Module Antenna Mounting Hole

The antenna mounting hole is used to mount and connect an antenna to the GPRS/UMTS/HSDPA module.

Reset Button

Press this button to restart VTC 6110.

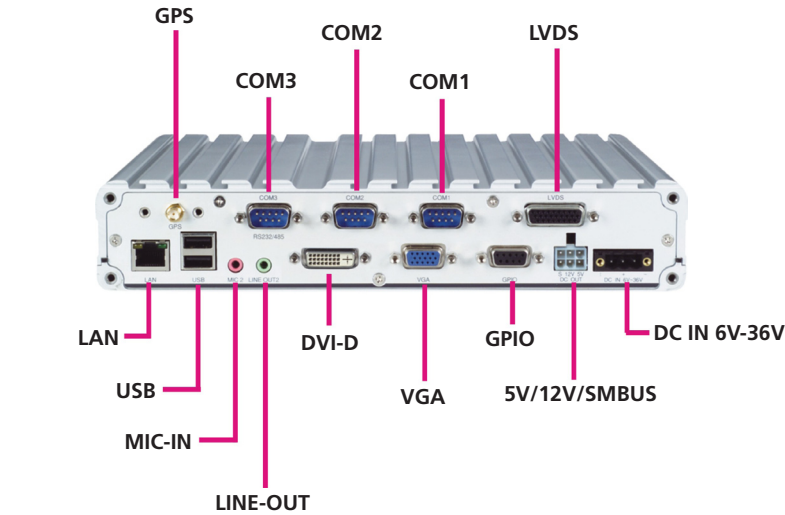
Line-out

Line-out is a stereo output for connecting external speakers.

Mic-in

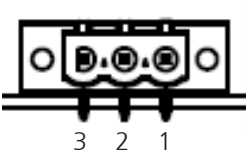
Mic-in receives monophonic input from an external microphone.

Rear Panel



Power Input

DC Power Input Connector
Connector location



Connector pin definition (CN1)

Pin No.	Function Description
1	GND
2	VIN(6V~36V)
3	IGNITION

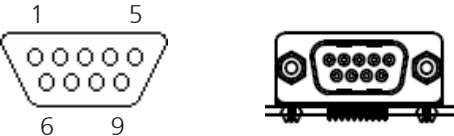
** Use power cable (+) with fuse for system protection

RS232/485 Connector COM3

The 9 pin D-Sub COM 3 port can be configured as RS232 or RS485 using the SW6 dip switch.

Connector size: DSUB-9 PIN

Connector location



Connector pin definition

Pin	Definition	Pin	Definition
1	DCD (RS232) TX-/RX- (RS485)	2	RXD (RS232) TX+/RX+ (RS485)
3	TXD (RS232)	4	DTR (RS232)
5	GND	6	DSR (RS232)
7	RTS (RS232)	8	CTS (RS232)
9	RI (RS232)		

RS232 Connector COM1 and COM2

Connector size: DSUB-9 PIN

Connector location



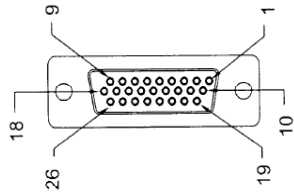
Connector pin definition

Pin	Definition	Pin	Definition
1	DCD	2	RXD
3	TXD	4	DTR
5	GND	6	DSR
7	RTS	8	CTS
9	RI		

LVDS

Connector size: DB-26 PIN

Connector location



Connector pin definition

Pin	Definition	Pin	Definition
1	Panel_EN	2	Panel_control
3	VDD	4	VDD
5	LCDD09(OUT3)	6	LCDD01(OUT0)
7	LCDD08(OUT3#)	8	LCDD00(OUT0#)
9	LCDD_GND	10	LCDD_GND
11	LCDD07(CLK)	12	LCDD03(OUT1)
13	LCDD06(CLK#)	14	LCDD02(OUT1#)
15	LVDS_GND	16	LCDD_GND
17	LCDD05(OUT2)	18	Power on push button
19	LCDD04(OUT2#)	20	Panel_backlight
21	LCDD_GND	22	Panel-Gnd
23	USB_0#	24	Contact_DET#
25	USB_0	26	USB_VCC

External SMBus, 12V and 5V Power Output

Connector location



Connector pin definition

Pin	Definition	Pin	Definition
1	5V	2	12V
3	SMBus Clock	4	GND
5	GND	6	SMBus Data

+5 VDC (1A) and +12VDC (1A) power output and SMBus (w/o VTK 33M-01 connection)

+5 VDC (0.5A) and +12VDC (0.5A) power output and SMBus (w/ VTK 33M-01 connection)

VGA Port

The DB15 VGA port supports resolutions up to 1600x1200 @ 85 Hz, 2048x1536 @ 60Hz.

USB Port x 2

The two USB ports are compliant with USB 2.0 specifications.

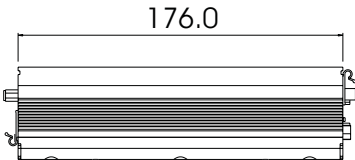
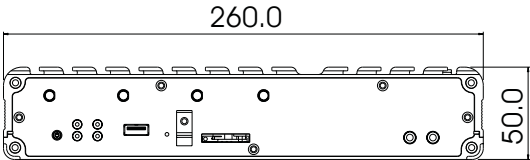
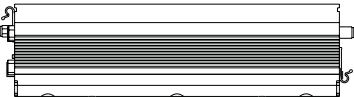
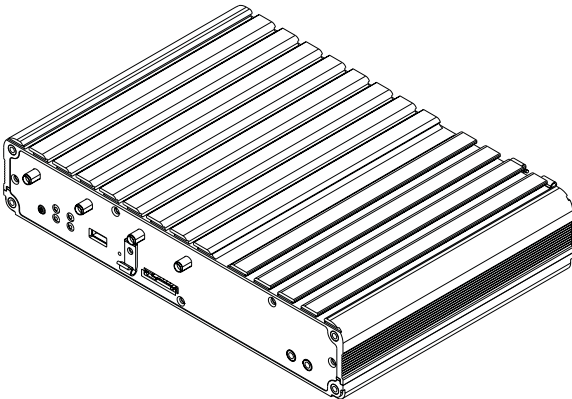
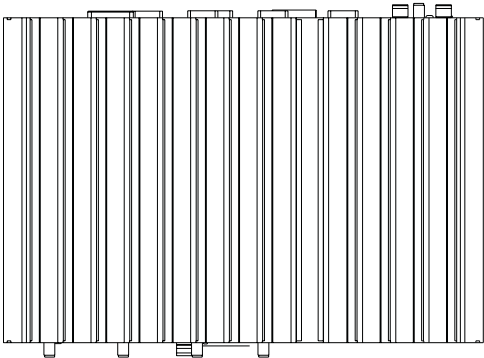
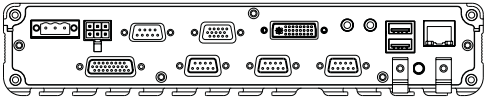
LAN Port

The LAN port is an RJ45 interface with integrated LEDs and supports 10/100/1000Mbps Ethernet data transfer rates.

Audio Jacks (MIC-IN and LINE-OUT)

- MIC-IN jack receives monophonic input from an external microphone.
- LINE-OUT jack is the stereo output for connecting external speakers.

Mechanical Dimensions



CHAPTER 2: JUMPERS AND CONNECTORS

This chapter describes how to set the jumpers on the motherboard. Note that the following procedures are generic for all VTC 6110 series.

Before You Begin

- Ensure you have a stable, clean working environment. Dust and dirt can get into components and cause a malfunction. Use containers to keep small components separated.
- Adequate lighting and proper tools can prevent you from accidentally damaging the internal components. Most of the procedures that follow require only a few simple tools, including the following:
 - A Philips screwdriver
 - A flat-tipped screwdriver
 - A set of jewelers Screwdrivers
 - A grounding strap
 - An anti-static pad
- Using your fingers can disconnect most of the connections. It is recommended that you do not use needle-nosed pliers to disconnect connections as these can damage the soft metal or plastic parts of the connectors.
- Before working on internal components, make sure that the power is off. Ground yourself before touching any internal components, by touching a metal object. Static electricity can damage many of the elec-

tronic components. Humid environment tend to have less static electricity than dry environments. A grounding strap is warranted whenever danger of static electricity exists.

Precautions

Computer components and electronic circuit boards can be damaged by discharges of static electricity. Working on the computers that are still connected to a power supply can be extremely dangerous.

Follow the guidelines below to avoid damage to your computer or yourself:

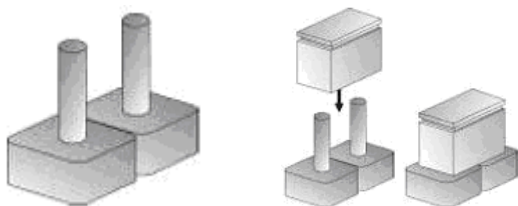
- Always disconnect the unit from the power outlet whenever you are working inside the case.
- If possible, wear a grounded wrist strap when you are working inside the computer case. Alternatively, discharge any static electricity by touching the bare metal chassis of the unit case, or the bare metal body of any other grounded appliance.
- Hold electronic circuit boards by the edges only. Do not touch the components on the board unless it is necessary to do so. Don't flex or stress the circuit board.
- Leave all components inside the static-proof packaging that they shipped with until they are ready for installation.
- Use correct screws and do not over tighten screws.

Jumper

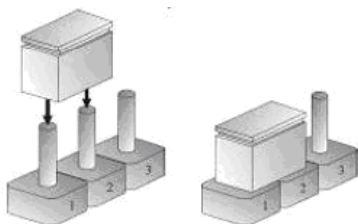
A jumper is the simplest kind of electric switch. It consists of two metal pins and a cap. When setting the jumpers, ensure that the jumper caps are placed on the correct pins. When the jumper cap is placed on both pins, the jumper is **short**. If you remove the jumper cap, or place the jumper cap on just one pin, the jumper is **open**.

Refer to the illustrations below for examples of what the 2-pin and 3-pin jumpers look like when they are short (on) and open (off).

Two-Pin Jumpers: Open (Left) and Short (Right)



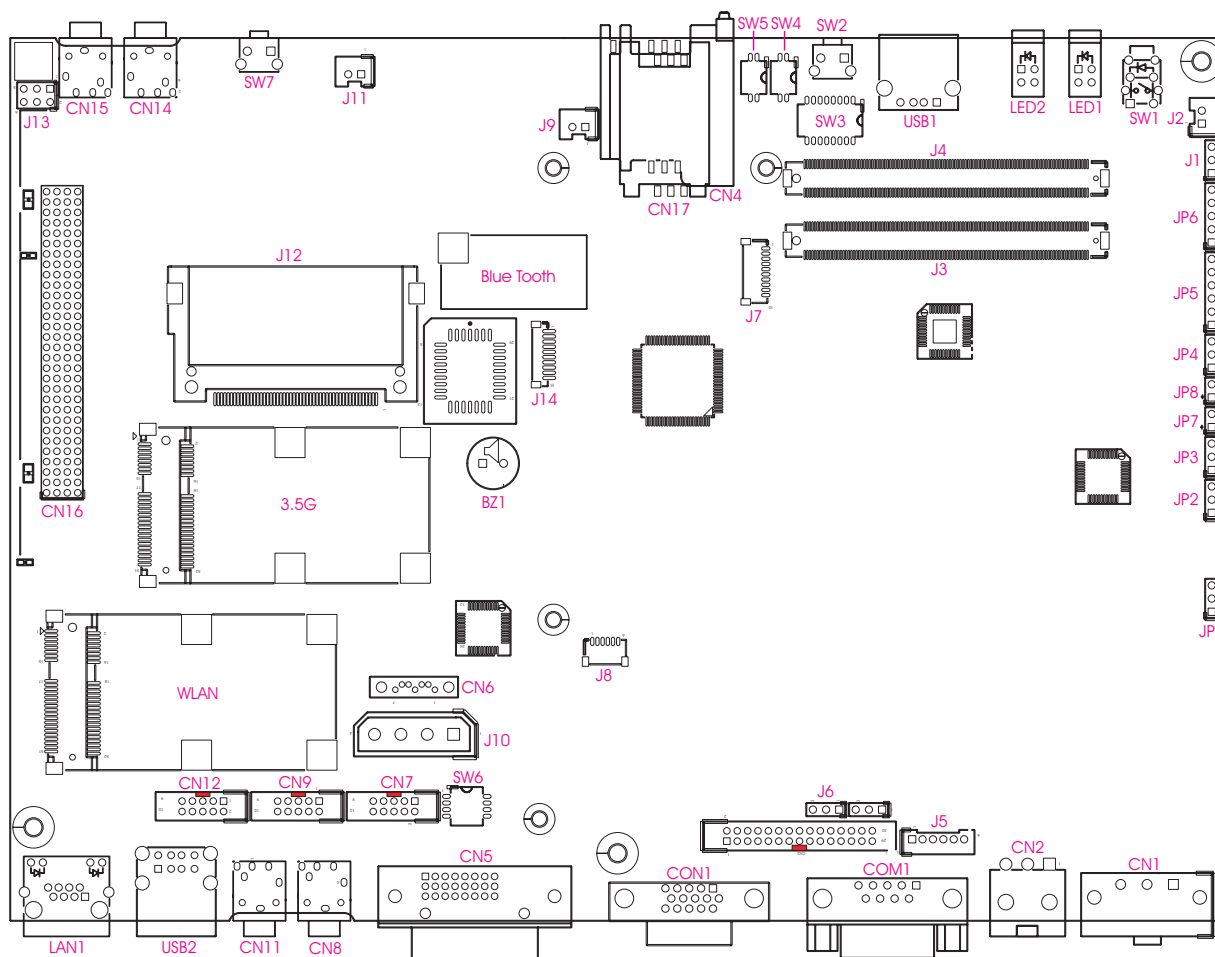
Three-Pin Jumpers: Pins 1 and 2 Are Short



Locations of the Jumpers and Connectors

VTCB6110

The figure on the right is the VTCB6110 carrier board which is the board used in the VTC6110 system. It shows the locations of the jumpers and connectors.



Jumper Settings

SW5: Input Voltage Selection

SW5 / Input Voltage	12V (default)	24V	6V~36V
SW5.1	OFF	OFF	ON
SW5.2	OFF	ON	Ignore

SW6: COM Port Mode Selection

SW6 COM Port Mode	RS232 (default)	RS485
SW6.1	OFF	ON
SW6.2	OFF	ON
SW6.3	OFF	ON

CF (IDE0) Primary Master/Slave Select (JP4)

Pin	Status	Function Description
1-2	Short	Slave
2-3 (default)	Short (default)	Master

LVDS Power Input Voltage Select (JP9)

Pin	Status	Function Description
1-2	Short	+5V IN
2-3 (default)	Short (default)	+3.3V IN

CMOS Input Voltage Select (J6)

Pin	Status	Function Description
1-2 (default)	Short (default)	VBAT IN
2-3	Short	Clear CMOS

BIOS Function Select (J1)

Pin	Status	Function Description
1-2	Short	Disable carrier board BIOS
2-3 (default)	Short (default)	Disable module board BIOS

DC Input Voltage Select (JP1)

Pin	Status	Function Description
1-2 (default)	Short (default)	IGNITION
2-3	Short	VIN_M

Temp Sensor (JP8)

Pin	Function Description
1	SENSOR+
2	GND

Auto Power Select (JP2)

Pin	Status	Function Description
1-2 (default)	Short (default)	AUTO
2-3	Short	BUTTON CONTROL

PCI-104 VI/O Select Voltage (J13)

Pin	Status	Function Description
1-4(*)	Short*	+3.3V
3-6	Short	+5V

MCU Download (JP6)

Pin	Function Description
1	+V3.3ALW
2	C2D
3	MRST
4	C2CK
5	GND

GAL Download (JP5)

Pin	Function Description
1	+V3.3S
2	GND
3	TCK
4	TDO
5	TDI
6	TMS

MCU COM Port (JP3)

Pin	Function Description
1	TX
2	RX
3	GND

Connectors

High Speed Board-to-Board Connector: COM Express Row A and Row B

Connector size: 2 x 110 = 220 pins

Connector location: J4



Connector Pin Definition

Row A		Row B		Row A		Row B	
A1	GND	B1	GND	A56	NC	B56	NC
A2	GBE0_MDI3-	B2	GBE0_ACT#	A57	GND	B57	NC
A3	GBE0_MDI3+	B3	LPC_FRAME#	A58	NC	B58	NC
A4	NC	B4	LPC_AD0	A59	NC	B59	NC
A5	NC	B5	LPC_AD1	A60	GND	B60	GND
A6	GBE0_MDI2-	B6	LPC_AD2	A61	NC	B61	NC
A7	GBE0_MDI2+	B7	LPC_AD3	A62	NC	B62	NC
A8	GBE0_LINK#	B8	NC	A63	GP11	B63	GPO3
A9	GBE0_MDI1-	B9	NC	A64	NC	B64	NC
A10	GBE0_MDI1+	B10	LPC_CLK	A65	NC	B65	NC
A11	GND	B11	GND	A66	GND	B66	NC
A12	GBE0_MDIO-	B12	PWRBTN#	A67	NC	B67	NC

Row A		Row B		Row A		Row B	
A13	GBE0_MDIO+	B13	SMB_CK	A68	PCIE_TX0+	B68	PCIE_RX0+
A14	GBE0_CTREF	B14	SMB_DAT	A69	PCIE_TX0-	B69	PCIE_RX0-
A15	SUS_S3#	B15	SMB_ALERT#	A70	GND	B70	GND
A16	SATA0_TX+	B16	NC	A71	LVDS_A0+	B71	NC
A17	SATA0_TX-	B17	NC	A72	LVDS_A0-	B72	NC
A18	SUS_S4#	B18	SUS_STAT#	A73	LVDS_A1+	B73	NC
A19	SATA0_RX+	B19	NC	A74	LVDS_A1+	B74	NC
A20	SATA0_RX-	B20	NC	A75	LVDS_A2+	B75	NC
A21	GND	B21	GND	A76	LVDS_A2+	B76	NC
A22	NC	B22	NC	A77	LVDS_VDD_EN	B77	NC
A23	NC	B23	NC	A78	LVDS_A3+	B78	NC
A24	SUS_S5#	B24	PWR_OK	A79	LVDS_A3+	B79	LVDS_BKLT_EN
A25	NC	B25	NC	A80	GND	B80	GND
A26	NC	B26	NC	A81	LVDS_A_CK+	B81	NC
A27	BATLOW#	B27	NC	A82	LVDS_A_CK-	B82	NC
A28	ATA_ACT#	B28	NC	A83	LVDS_I2C_CK	B83	LVDS_BKLT_CTRL
A29	AC_SYNC	B29	NC	A84	LVDS_I2C_DAT	B84	VCC_5V_SBY
A30	AC_RST#	B30	AC_SDINO	A85	NC	B85	VCC_5V_SBY
A31	GND	B31	GND	A86	NC	B86	VCC_5V_SBY
A32	AC_BITCLK	B32	SPKR	A87	NC	B87	VCC_5V_SBY
A33	AC_SDOOUT	B33	I2C_CK	A88	PCIE0_CK_REF+	B88	RSVD
A34	NC	B34	I2C_DAT	A89	PCIE0_CK_REF-	B89	NC
A35	NC	B35	THRM#	A90	GND	B90	GND
A36	USB6-	B36	NC	A91	RSVD	B91	NC
A37	USB6+	B37	NC	A92	RSVD	B92	NC
A38	USB_6_7_OC#	B38	USB_4_5_OC#	A93	NC	B93	NC
A39	USB4-	B39	USB5-	A94	RSVD	B94	NC

Row A		Row B		Row A		Row B	
A40	USB4+	B40	USB5+	A95	RSVD	B95	NC
A41	GND	B41	GND	A96	GND	B96	NC
A42	USB2-	B42	USB3-	A97	VCC_12V	B97	NC
A43	USB2+	B43	USB3+	A98	VCC_12V	B98	NC
A44	USB_2_3_OC#	B44	USB_0_1_OC#	A99	VCC_12V	B99	NC
A45	USB0-	B45	USB1-	A100	GND	B100	GND
A46	USB0+	B46	USB1+	A101	VCC_12V	B101	VCC_12V
A47	VCC_RTC	B47	NC	A102	VCC_12V	B102	VCC_12V
A48	NC	B48	NC	A103	VCC_12V	B103	VCC_12V
A49	NC	B49	SYS_RESET#	A104	VCC_12V	B104	VCC_12V
A50	NC	B50	CB_RESET#	A105	VCC_12V	B105	VCC_12V
A51	GND	B51	GND	A106	VCC_12V	B106	VCC_12V
A52	NC	B52	NC	A107	VCC_12V	B107	VCC_12V
A53	NC	B53	NC	A108	VCC_12V	B108	VCC_12V
A54	NC	B54	NC	A109	VCC_12V	B109	VCC_12V
A55	NC	B55	NC	A110	GND	B110	GND

High Speed Board-to-Board Connector: COM Express Row C and Row D

Connector size: 2 X 110 = 220 Pins

Connector location: J3



Connector Pin Definition

Row C		Row D		Row C		Row D	
C1	GND	D1	GND	C56	NC	D56	SDVOB_GREEN-
C2	IDE_D7	D2	IDE_D5	C57	NC	D57	NC
C3	IDE_D6	D3	IDE_D10	C58	NC	D58	SDVOB_BLUE+
C4	IDE_D3	D4	IDE_D11	C59	NC	D59	SDVOB_BLUE-
C5	IDE_D15	D5	IDE_D12	C60	GND	D60	GND
C6	IDE_D8	D6	IDE_D4	C61	NC	D61	SDVO_CLK+
C7	IDE_D9	D7	IDE_D0	C62	NC	D62	SDVO_CLK-
C8	IDE_D2	D8	IDE_REQ	C63	NC	D63	NC
C9	IDE_D13	D9	IDE_IOW#	C64	NC	D64	NC
C10	IDE_D1	D10	IDE_ACK#	C65	NC	D65	NC
C11	GND	D11	GND	C66	NC	D66	NC
C12	IDE_D14	D12	IDE_IRQ	C67	NC	D67	GND

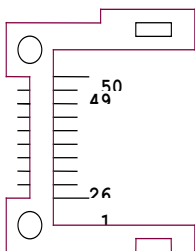
Row C		Row D		Row C		Row D	
C13	IDE_IORDY	D13	IDE_A0	C68	NC	D68	NC
C14	IDE_IOR#	D14	IDE_A1	C69	NC	D69	NC
C15	NC	D15	IDE_A2	C70	GND	D70	GND
C16	NC	D16	IDE_CS1#	C71	NC	D71	NC
C17	NC	D17	IDE_CS3#	C72	NC	D72	NC
C18	NC	D18	IDE_RESET#	C73	NC	D73	SDVO_CLK
C19	NC	D19	NC	C74	NC	D74	NC
C20	PCI_GNT0#	D20	NC	C75	NC	D75	NC
C21	GND	D21	GND	C76	GND	D76	GND
C22	PCI_REQ0#	D22	PCI_AD1	C77	NC	D77	IDE_CBLID#
C23	PCI_RESET#	D23	PCI_AD3	C78	NC	D78	NC
C24	PCI_AD0	D24	PCI_AD5	C79	NC	D79	NC
C25	PCI_AD2	D25	PCI_AD7	C80	GND	D80	GND
C26	PCI_AD4	D26	PCI_C/BE0#	C81	NC	D81	NC
C27	PCI_AD6	D27	PCI_AD9	C82	NC	D82	NC
C28	PCI_AD8	D28	PCI_AD11	C83	NC	D83	NC
C29	PCI_AD10	D29	PCI_AD13	C84	GND	D84	GND
C30	PCI_AD12	D30	PCI_AD15	C85	NC	D85	NC
C31	GND	D31	GND	C86	NC	D86	NC
C32	PCI_AD14	D32	PCI_PAR	C87	GND	D87	GND
C33	PCI_C/BE1#	D33	PCI_SERR#	C88	NC	D88	NC
C34	PCI_PERR#	D34	PCI_STOP#	C89	NC	D89	NC
C35	PCI_LOCK#	D35	PCI_TRDY#	C90	GND	D90	GND
C36	PCI_DEVSEL#	D36	PCI_FRAME#	C91	NC	D91	NC
C37	PCI_IRDY#	D37	PCI_AD16	C92	NC	D92	NC
C38	PCI_C/BE2#	D38	PCI_AD18	C93	GND	D93	GND
C39	PCI_AD17	D39	PCI_AD20	C94	NC	D94	NC

Row C		Row D		Row C		Row D	
C40	PCI_AD19	D40	PCI_AD22	C95	PEG_RX13-	D95	PEG_TX13-
C41	GND	D41	GND	C96	GND	D96	GND
C42	PCI_AD21	D42	PCI_AD24	C97	RSVD	D97	PEG_ENABLE#
C43	PCI_AD23	D43	PCI_AD26	C98	PEG_RX14+	D98	PEG_TX14+
C44	PCI_C/BE3#	D44	PCI_AD28	C99	PEG_RX14-	D99	PEG_TX14-
C45	PCI_AD25	D45	PCI_AD30	C100	GND	D100	GND
C46	PCI_AD27	D46	PCI_IRQC#	C101	PEG_RX15+	D101	PEG_TX15+
C47	PCI_AD29	D47	PCI_IRQD#	C102	PEG_RX15-	D102	PEG_TX15-
C48	PCI_AD31	D48	PCI_CLKRUN#	C103	GND	D103	GND
C49	PCI_IRQA#	D49	PCI_M66EN	C104	VCC_12V	D104	VCC_12V
C50	PCI_IRQB#	D50	PCI_CLK	C105	VCC_12V	D105	VCC_12V
C51	GND	D51	GND	C106	VCC_12V	D106	VCC_12V
C52	PEG_RX0+	D52	PEG_TX0+	C107	VCC_12V	D107	VCC_12V
C53	PEG_RX0-	D53	PEG_TX0-	C108	VCC_12V	D108	VCC_12V
C54	TYPE0#	D54	PEG_LANE_RV#	C109	VCC_12V	D109	VCC_12V
C55	PEG_RX1+	D55	PEG_TX1+	C110	GND	D110	GND

CompactFlash Connector

Connector size: 2 x 25 = 50 pins

Connector location: J12



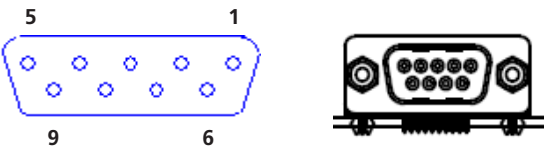
Connector Pin Definition

Pin	Description	Pin	Description
1	Gnd	2	Data 3
3	Data 4	4	Data 5
5	Data 6	6	Data 7
7	HDC CS100	8	Gnd
9	Gnd	10	Gnd
11	Gnd	12	Gnd
13	+5V	14	Gnd
15	Gnd	16	Gnd
17	Gnd	18	Disk Address 2
19	Disk Address 1	20	Disk Address 0
21	Data 0	22	Data 1

Pin	Description	Pin	Description
23	Data 2	24	IOCS16# (NC)
25	CF_CD2# (Pull-down)	26	CF_CD1# (Pull-down)
27	Data 11	28	Data 12
29	Data 13	30	Data 14
31	Data 15	32	HDC CS300
33	CF_VS1# (NC)	34	IOR
35	IOW	36	CF_WE# (+5V)
37	Interrupt 15	38	+5V
39	CF_CSEL# (Master or Slave)	40	CF_VS2# (NC)
41	Reset #	42	IOCHRDY
43	DMA REQ / DACK (NC)	44	DMA ACK# /CF_REG# (+5V)
45	HDD Active Led	46	DMA66 Detect / CF_PDIAG#
47	Data 8	48	Data 9
49	Data 10	50	Gnd

GPIO Connector

Connector size: DSUB-9 pin
Connector location: COM1

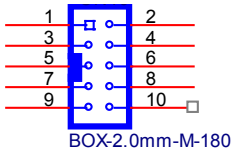


Connector Pin Definition

Pin	Description	Pin	Description
1	GIN1	2	GIN2
3	GIN3	4	GIN4
5	GOUT4	6	GOUT1
7	GOUT2	8	GOUT3
9	GND		

RS232 Connector: COM1, COM2

Connector size: 2 x 10 = 20 Pins Pin Header, (2.0 mm Pitch)
Connector location: COM1 (CN9), COM2 (CN7)

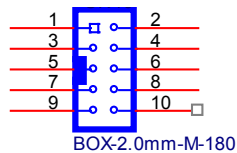


Connector Pin Definition

Pin	Definition	Pin	Definition
1	DCD	2	RXD
3	TXD	4	DTR
5	Gnd	6	DSR
7	RTS	8	CTS
9	RI		

RS232/485 Connector: COM3

Connector size: 2 x 10 = 20 Pins Pin Header, (2.0 mm Pitch)
Connector location: CN12

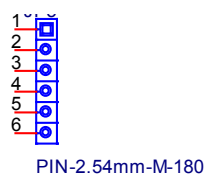


Connector Pin Definition

Pin	Definition	Pin	Definition
1	DCD (RS232) TX-/RX- (RS485)	2	RXD (RS232) TX+/RX+ (RS485)
3	TXD (RS232)	4	DTR (RS232)
5	Gnd	6	DSR (RS232)
7	RTS (RS232)	8	CTS (RS232)
9	RI (RS232)		

GAL Programmer PIN Header

Connector size: 2.54mm-M-180
Connector location: JP5

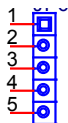


Connector Pin Definition

Pin	Definition	Pin	Definition
1	+3.3V	2	GND
3	TCK	4	TDO
5	TDI	6	TMS

MCU Programmer Pin Header

Connector size: 2.54mm-M-180
Connector location: JP6



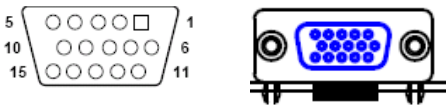
PIN-2.54mm-M-180

Connector Pin Definition

Pin	Definition	Pin	Definition
1	+3.3ALW	2	C2D
3	MRST	4	C2CK
5	GND		

VGA Connector

Connector size: DSUB-15
Connector location: CON1



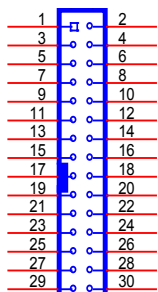
Connector Pin Definition

Pin	Definition	Pin	Definition
1	RED	2	GREEN
3	BLUE	4	NC
5	Gnd	6	Gnd
7	Gnd	8	Gnd
9	VCC	10	Gnd
11	NC	12	DDCDAT
13	Hsync	14	Vsync
15	DDCCLK		

LVDS Connector + USB0

Connector size: 2 x 15 (2.0mm)

Connector location: CN3



BOX-2.0mm-M-180

Connector Pin Definition

Pin	Definition	Pin	Definition
1	LVDS_CLK	2	LVDS_DAT
3	Panel_VDD	4	LVDS_1(OUT0)
5	LVDS_9(OUT3)	6	LVDS_0(OUT0#)
7	LVDS_8(OUT3#)	8	Panel_VDD
9	LVDS_GND	10	LVDS_GND
11	LVDS_7(CLK)	12	LVDS_3(OUT1)
13	LVDS_6(CLK#)	14	LVDS_2(OUT1#)
15	LVDS_GND	16	LVDS_GND

Pin	Definition	Pin	Definition
17	LVDS_5(OUT2)	18	Panel_backlight(+12V)
19	LVDS_4(OUT2#)	20	Panel_backlight(+12V)
21	LVDS_GND	22	Power on push button
23	USB_0#	24	Contact_DET#
25	USB_0	26	USB_VCC (+5V)
27	USB_GND	28	USB_GND
29	Panel_backlight(+12V)	30	GND

LAN Connector

Connector size: RJ-45
Connector location: LAN1



Connector Pin Definition

Pin	Definition	Pin	Definition
1	TX+	2	TX-
3	RX+	4	N/C1
5	N/C2	6	RX-
7	N/C3	8	N/C4
9	LAN Speed LED	10	+3.3V
11	LAN Link LED	12	+3.3V

USB Connector

Connector location: USB1



Connector Pin Definition

Pin	Definition	Pin	Definition
1	VCC	2	DATA-
3	DATA+	4	GND

USB Connector

Connector location: USB2



Connector Pin Definition

Pin	Definition	Pin	Definition
1	VCC	2	DATA1-
3	DATA1+	4	GND
5	VCC	6	DATA-
7	DATA+	8	GND

LVDS Power Connector

Connector location: J5



Connector Pin Definition

Pin	Definition	Pin	Definition
1	Panel_backlight	2	Panel_VDD
3	GND	4	GND
5	LVDS_PANEL	6	LVDS_BIASON

External 12V & 5V Power and SMBUS Connector

Connector location: CN2



Connector Pin Definition

Pin	Definition	Pin	Definition
1	5V	2	12V
3	SMBCLK	4	GND
5	GND	6	SMBDATA

Mic-in

Connector location: CN11 and CN15



Connector Pin Definition

Pin	Definition	Pin	Definition
1	NC	2	MIC_JD
3	NC	4	MIC_OUT
5	GND	6	GND

Line-out

Connector location: CN8 and CN14

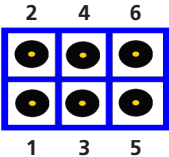


Connector Pin Definition

Pin	Definition	Pin	Definition
1	LINE_OUT_L	2	SURR_JD
3	NC	4	LINE_OUT_R
5	GND	6	GND

PCI-104 VI/O Voltage Setting

Connector location: J13

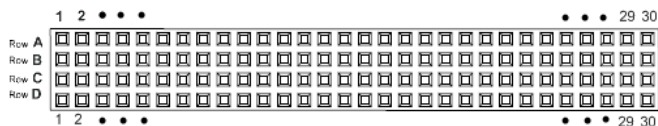


Connector Pin Definition

Pin No.	Status	Function Description
1-3, 2-4 (default)	Short	+3.3V
3-5, 4-6	Short	+5V

PCI-104 Connector

Connector location: CN16

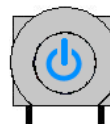


Connector Pin Definition

Pin	A	B	C	D
1	GND	Reserved	+5	AD00
2	VI/O	AD02	AD01	+5V
3	AD05	GND	AD04	AD03
4	C/BE0#	AD07	GND	AD06
5	GND	AD09	AD08	GND
6	AD11	VI/O	AD10	M66EN
7	AD14	AD13	GND	AD12
8	+3.3V	C/BE1#	AD15	+3.3V
9	SERR#	GND	Reserved	PAR
10	GND	PERR#	+3.3V	Reserved
11	STOP#	+3.3V	LOCK#	GND
12	+3.3V	TRDY#	GND	DEVSEL#
13	FRAME#	GND	IRDY#	+3.3V
14	GND	AD16	+3.3V	C/BE2#
15	AD18	+3.3V	AD17	GND
16	AD21	AD20	GND	AD19
17	+3.3V	AD23	AD22	+3.3V
18	IDSEL0	GND	IDSEL1	IDSEL2
19	AD24	C/BE3#	VI/O	IDSEL3
20	GND	AD26	AD25	GND
21	AD29	+5V	AD28	AD27
22	+5V	AD30	GND	AD31
23	REQ0#	GND	REQ1#	VI/O
24	GND	REQ2#	+5V	GNT0#
25	GNT1#	VI/O	GNT2#	GND
26	+5V	CLK0	GND	CLK1
27	CLK2	+5V	CLK3	GND
28	GND	INTD#	+5V	RST#
29	+12V	INTA#	INTB#	INTC#
30	-12V	REQ3#	GNT3#	GND

Power Button

Connector location: SW1



Reset Button

Connector location: SW2





MCU COM Port

Connector location: JP3

Connector Pin Definition

Pin	Function Description
1	TX
2	RX
3	GND

ACC_ON LED

Connector location: JP7



Connector Pin Definition

Pin	Function Description
1	+3.3V LED
2	GND



Temp Sensor

Connector location: JP8



Connector Pin Definition

Pin	Function Description
1	SENSOR+
2	GND

DC Power Input Connector

Connector location: CN1



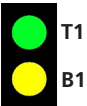
Connector Pin Definition

Pin	Function Description
1	GND
2	VIN (6V~36V)
3	IGNITION



Power On and IDE Active LED

Connector location: LED1

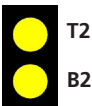


Connector Pin Definition

LED	Function Description
T1	POWER LED
B1	HD LED

GPIO and UMTS LEDs

Connector location: LED2



LED I/O Port Address and Data

LED	Function Description
T2	I/O PORT Address: 0EE0; Bit0: 1 (Light), 0 (Dark)
B2	UMTS STATUS

Serial ATA

Connector location: CN6



Connector Pin Definition

Pin	Definition	Pin	Definition
1	GND	2	SATA_TXP0 -
3	SATA_TXN0	4	GND
5	SATA_RXN0	6	SATA_RXP0
7	GND		

Serial ATA Power Input

Connector location: J10

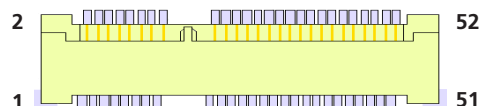


Connector Pin Definition

Pin	Definition	Pin	Definition
1	+V12S	2	GND
3	GND	4	+V5S

Mini-PCle Socket (for 3.5G module) PCIe Interface

Connector location: CN10

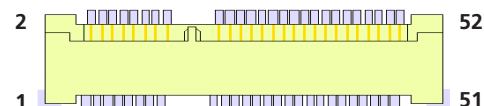


Connector Pin Definition

Pin	Definition	Pin	Definition	Pin	Definition	Pin	Definition
1	MIC +	2	+V3.3S	27	GND	28	NC
3	MIC -	4	GND	29	GND	30	NC
5	SPK +	6	NC	31	NC	32	NC
7	GND	8	USIM PWR	33	RESET	34	GND
9	GND	10	USIM DATA	35	GND	36	USB_D-
11	VCC_MSM26_DIG	12	USIM CLK	37	GND	38	USB_D+
13	NC	14	USIM RST	39	+V3.3S	40	GND
15	GND	16	NC	41	+V3.3S	42	LED_WWAN#
17	NC	18	GND	43	GND	44	NC
19	NC	20	W_DISABLE#	45	NC	46	NC
21	GND	22	NC	47	NC	48	NC
23	NC	24	NC	49	NC	50	GND
25	NC	26	GND	51	NC	52	+V3.3S

Mini-PCle Socket (for WLAN module) USB + PCIe Interface

Connector location: CN13

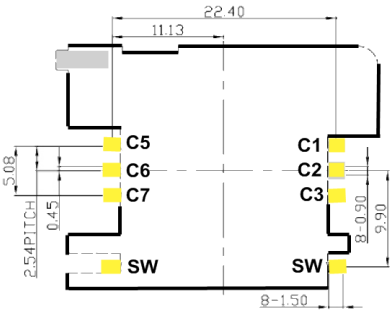


Connector Pin Definition

Pin	Definition	Pin	Definition	Pin	Definition	Pin	Definition
1	WAKE#	2	+V3.3S	27	GND	28	+V1.5S
3	NC	4	GND	29	GND	30	SMB_CLK
5	NC	6	+V1.5S	31	PETn0	32	SMB_DATA
7	CLKREQ#	8	NC	33	PETp0	34	GND
9	GND	10	NC	35	GND	36	USB_D-
11	REFCLK-	12	NC	37	NC	38	USB_D+
13	REFCLK+	14	NC	39	NC	40	GND
15	GND	16	NC	41	NC	42	LED_WWAN#
17	NC	18	GND	43	NC	44	LED_WLAN#
19	NC	20	DISABLE#	45	NC	46	LED_WPAN#
21	GND	22	PERST#	47	NC	48	+V1.5S
23	PERn0	24	+3.3S	49	NC	50	GND
25	PERp0	26	GND	51	NC	52	+V3.3S

SIM Card Connector

Connector location: CN4

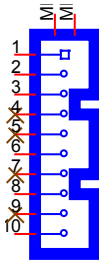


Connector Pin Definition

Pin	Definition	Pin	Definition
C1	POWER VOLTAGE	C2	RESET SIGNAL
C3	CLOCK SIGNAL	C5	GND
C6	VPP:PROGRAM VOLTAGE	C7	I/O
SW	Contact present switch		

Bluetooth Connector

Connector location: J7



Pin	Definition	Pin	Definition
1	GND	2	USB_6P_L
3	USB_6N_L	4	NC
5	NC	6	BT_AUDIO_EN_R
7	NC	8	BT_3.3V
9	NC	10	GND

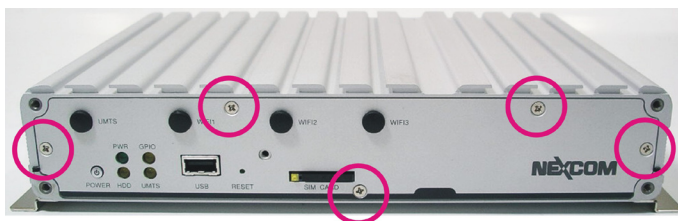
CHAPTER 3: SYSTEM SETUP

Removing the Chassis Cover



Prior to removing the chassis cover, make sure the unit's power is off and disconnected from the power sources to prevent electric shock or system damage.

1. The screws on the cover are used to secure the cover to the chassis. Remove these screws and put them in a safe place for later use.



Front View



Rear View



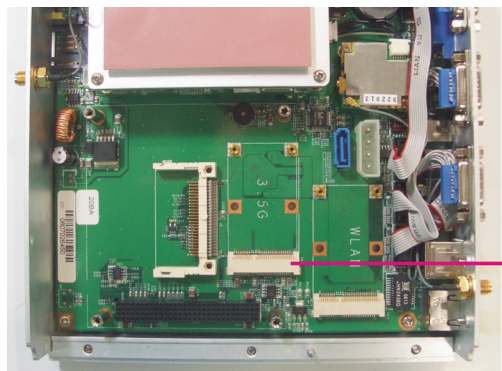
Bottom View

2. Lift the cover upward then remove it from the chassis.



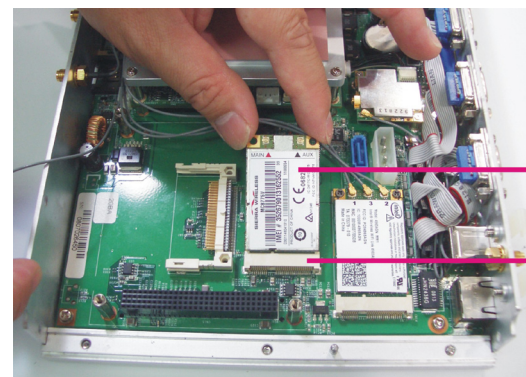
Installing a GPRS/UMTS/HSDPA Module

1. The Mini PCI Express slot shown below is used to install a 3.5G communication module such as GPRS, UMTS or HSDPA module.



Mini PCI Express slot

2. Insert the module into the Mini PCI Express slot at a 45 degrees angle until the gold-plated connector on the edge of the module completely disappears inside the slot.



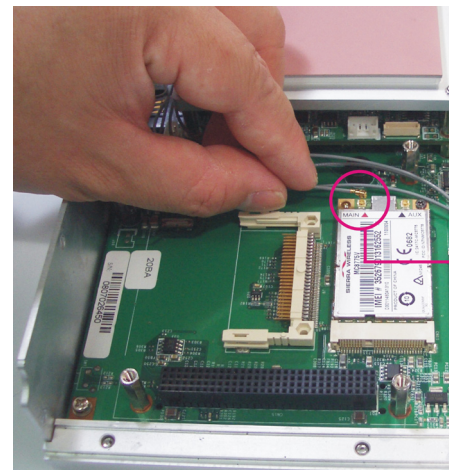
GPRS/UMTS/HSDPA module

Mini PCI Express slot

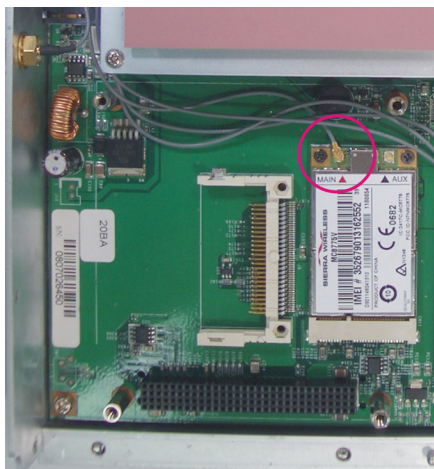
3. Push the module down then secure it with mounting screws.



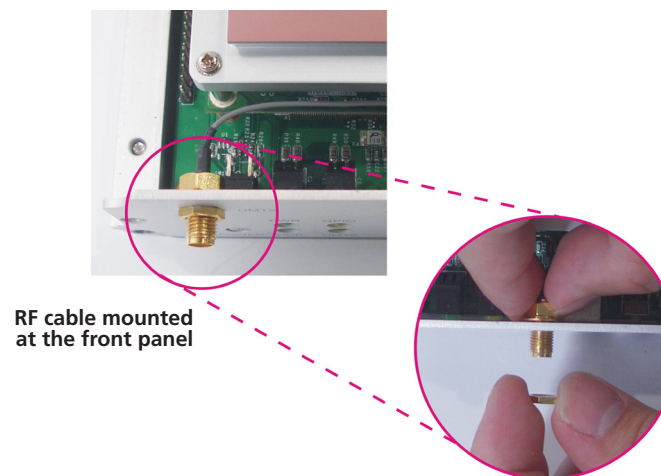
4. Attach one end of the RF cable onto the module.



5. The photo below shows one end of the RF cable properly attached onto the module.



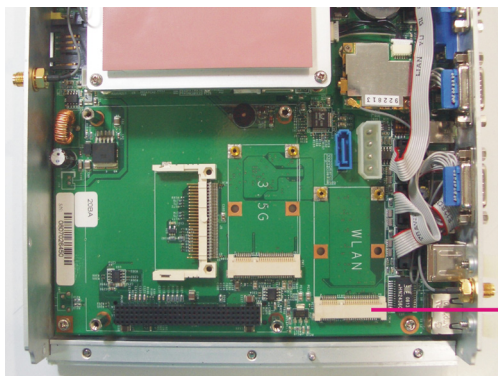
6. Mount the other end of the cable to the antenna mounting hole located at the front panel of the chassis.



RF cable mounted
at the front panel

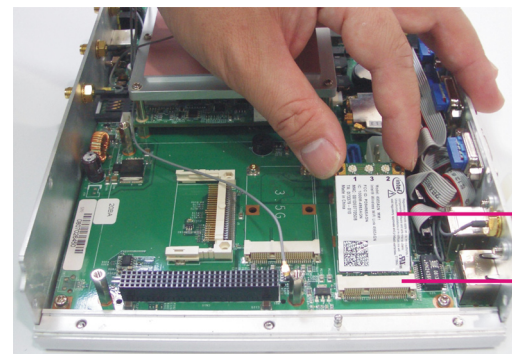
Installing a Wireless LAN Module

1. The Mini PCI Express slot shown below is used to install a wireless LAN module.



Mini PCI Express slot

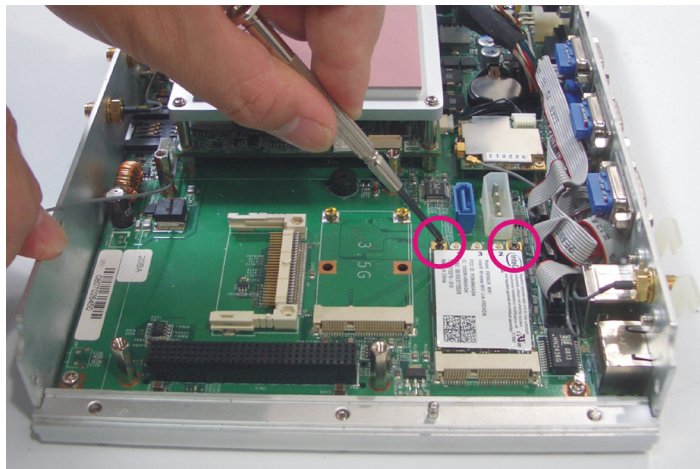
2. Insert the wireless LAN module into the Mini PCI Express slot at a 45 degrees angle until the gold-plated connector on the edge of the module completely disappears inside the slot.



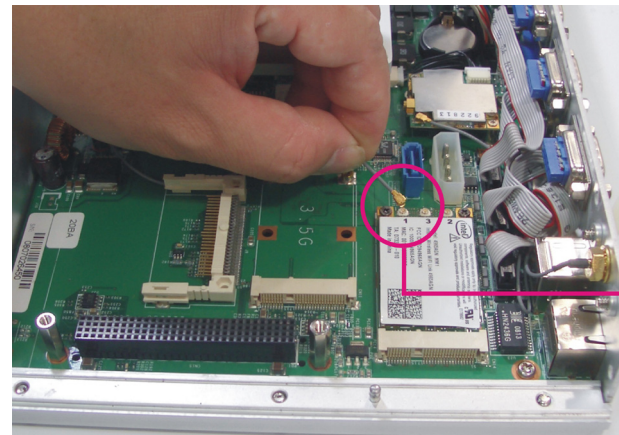
Wireless LAN module

Mini PCI Express slot

3. Push the module down then secure it with mounting screws.

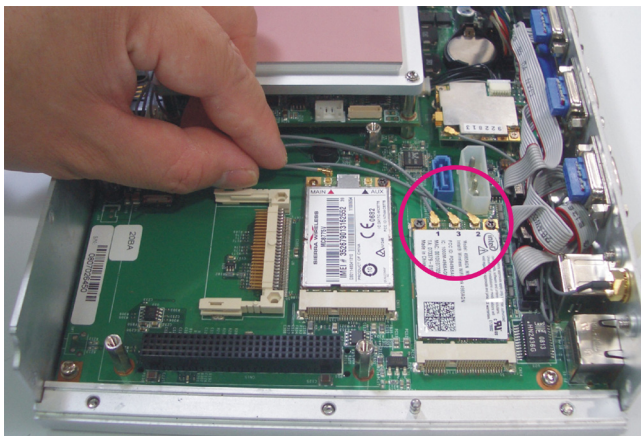


4. Attach one end of the RF cable onto the module.

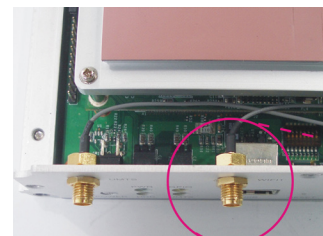


Attach RF
cable to the
module

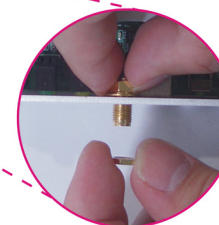
5. The photo below shows one end of the RF cable properly attached onto the module.



6. Mount the other end of the cable to the antenna mounting hole located at the front panel of the chassis.

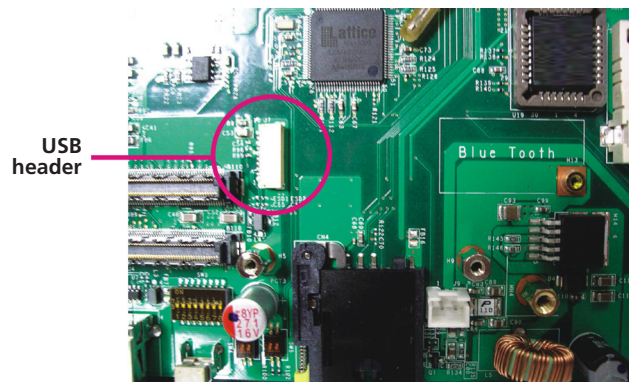


**RF cable mounted
at the front panel**

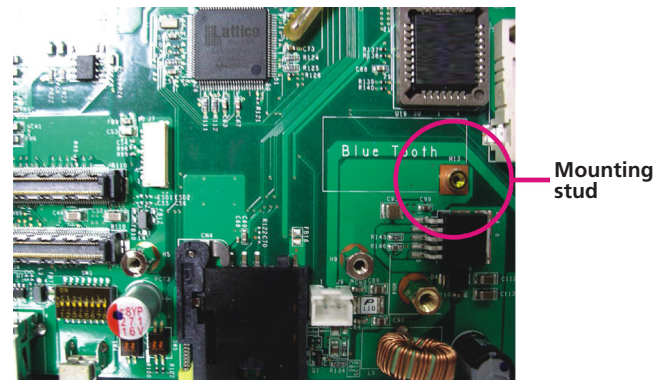


Installing a Bluetooth Module

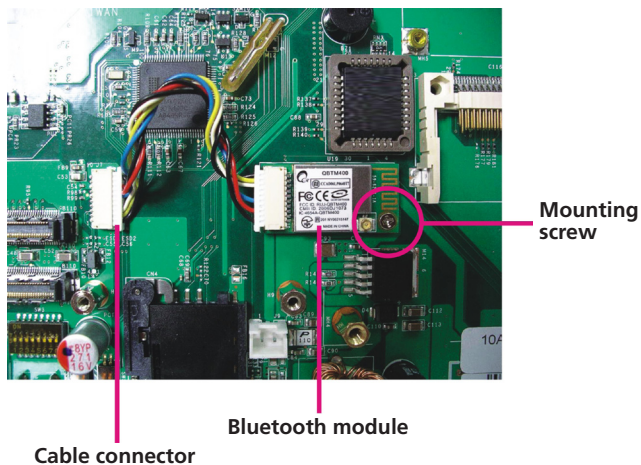
1. The USB header shown below is used to install a Bluetooth module.



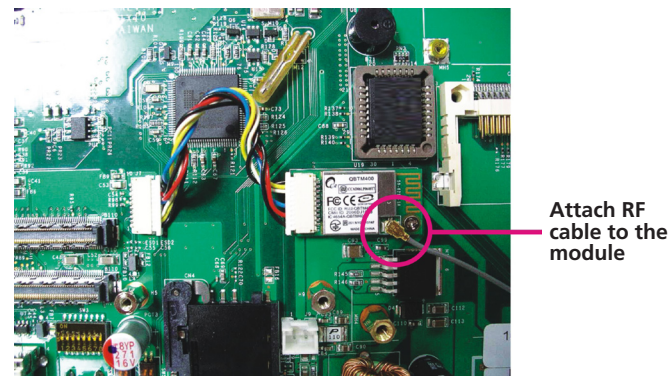
2. Install the provided mounting stud as shown in the illustration below.



3. Insert the Bluetooth module's cable connector into the USB header.
Push the module down then secure it with a mounting screw.



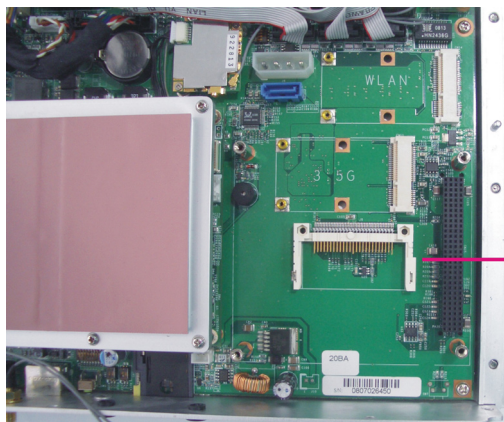
4. Attach one end of the RF cable onto the module.



5. Mount the other end of the cable to the Bluetooth mounting hole located at the front panel of the chassis.

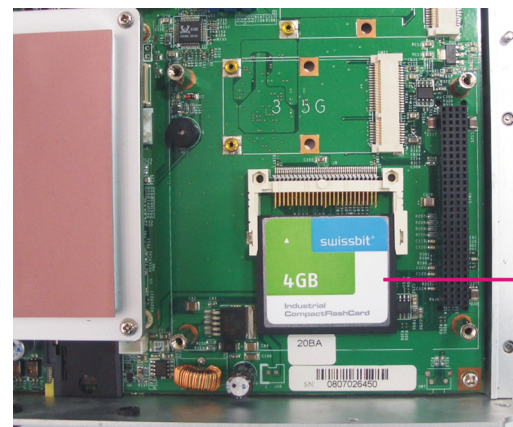
Installing a CompactFlash Card

1. Locate for the CompactFlash socket on the board.



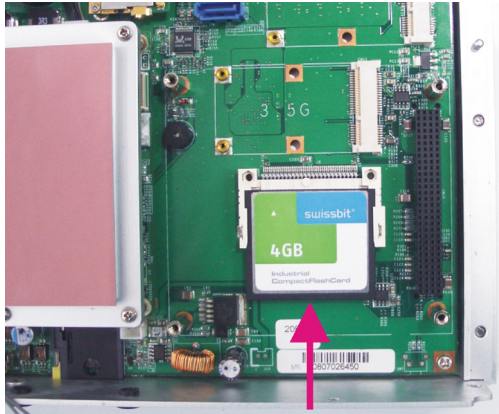
CompactFlash
socket

2. With the CompactFlash card's label facing up, position the card to the socket.



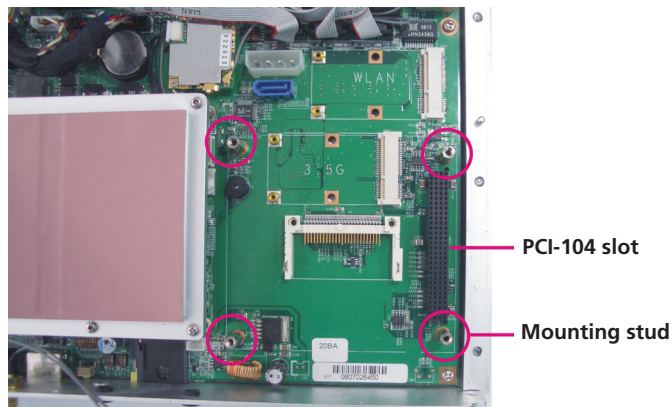
CompactFlash
card

3. Insert the card until it is completely seated in the socket.

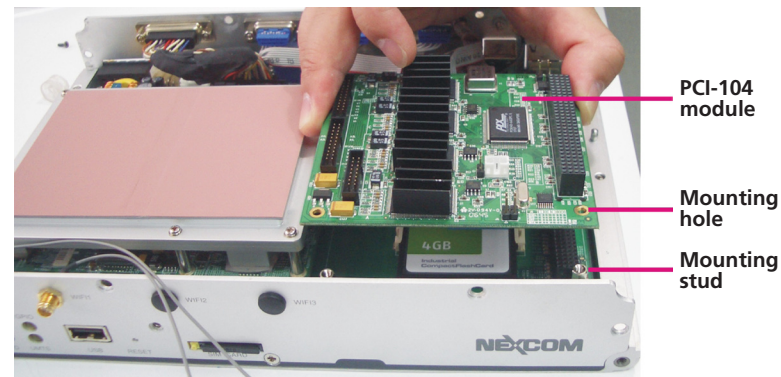


Installing the PCI-104 Module

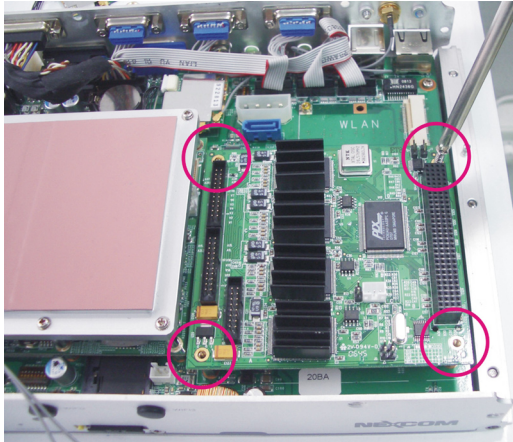
1. Locate for the PCI-104 slot on the board.



2. Position the PCI-104 module above the slot then press it down firmly until it is completely seated in the slot. This will at the same time align the module's mounting holes to the mounting studs on the board.

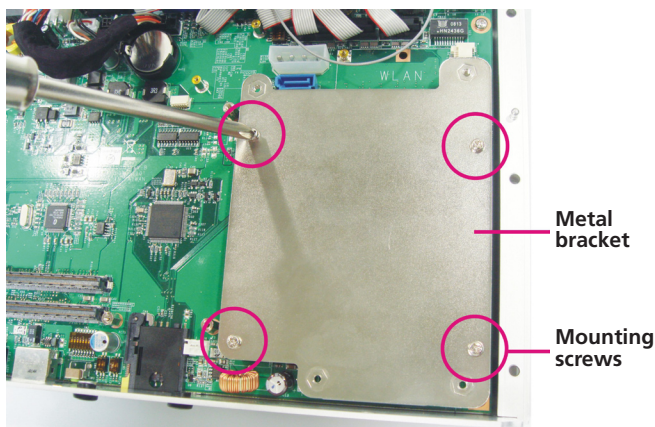


3. Secure the module with mounting screws.



Installing a SATA Hard Drive

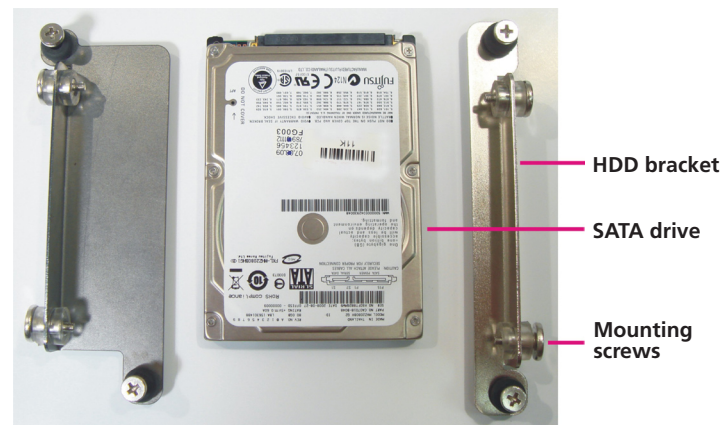
1. The metal bracket is used to hold a SATA hard drive. First, remove the screws that secure the metal bracket to the board then remove the bracket.



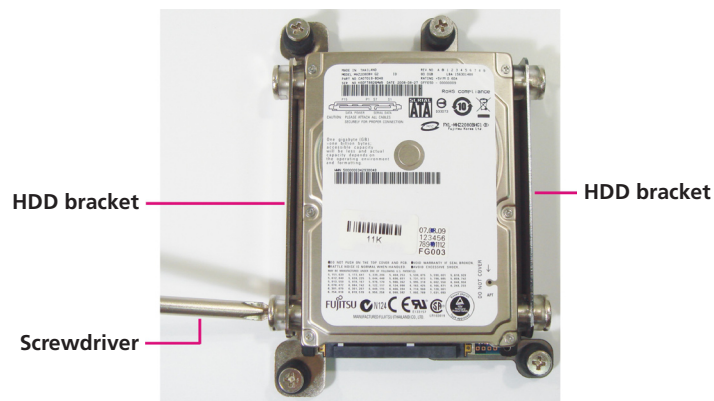
 If you intend to install a CompactFlash card or a Mini PCI Express module, please install these devices first before proceeding to the next step. Refer to their respective sections in this chapter for instructions on installing a CF card or a Mini PCI Express module.



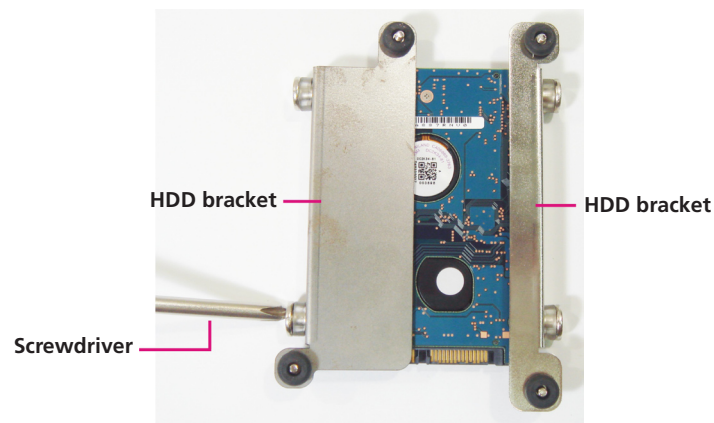
- During Windows XP OS installation, press “F6” to select and install the SATA driver.
 - If you intend to install a Windows XP SP2 or earlier version, you must first set the “USB 2.0 Controller” field (in the BIOS) to Disabled.
 - By default, the “Legacy USB Support” field (in the BIOS) is Disabled. If you are using a USB device to install the Windows operating system, you must first set this field to Enabled. Set this field back to Disabled after you have finished the installation.
2. Position the HDD brackets on each side of the SATA drive. Align the mounting holes that are on the sides of the SATA drive with the HDD brackets' mounting screws.



3. Tighten the mounting screws to secure the HDD brackets in place.

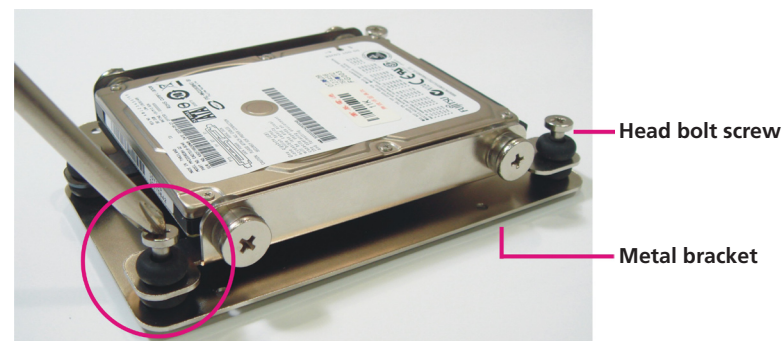


Top View

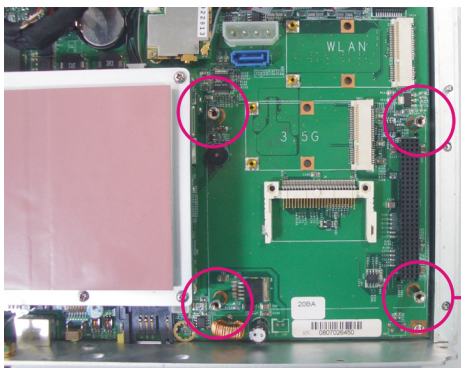


Bottom View

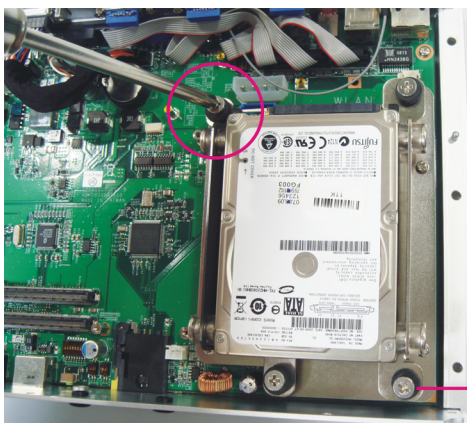
4. Now place the SATA drive on the metal bracket then tighten the head bolt screws to secure the drive on the metal bracket.



5. Align the head bolt screws with the mounting studs on the board.
Tighten the head bolt screws to secure the drive to the chassis.

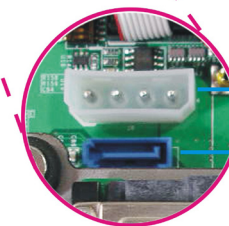
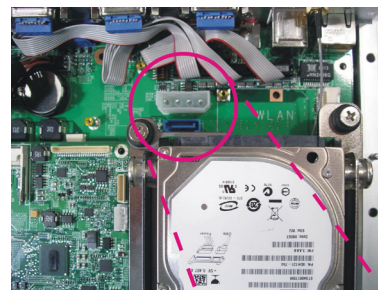


Mounting stud



Head bolt screw

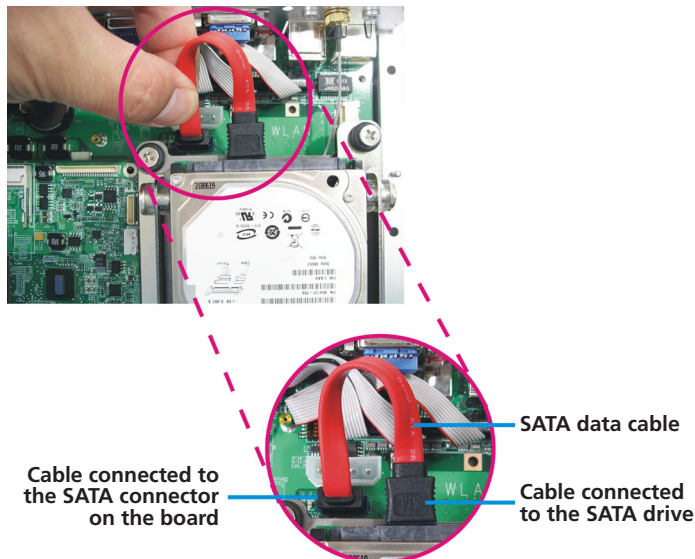
6. Locate for the SATA connector and the power connector. on the board.



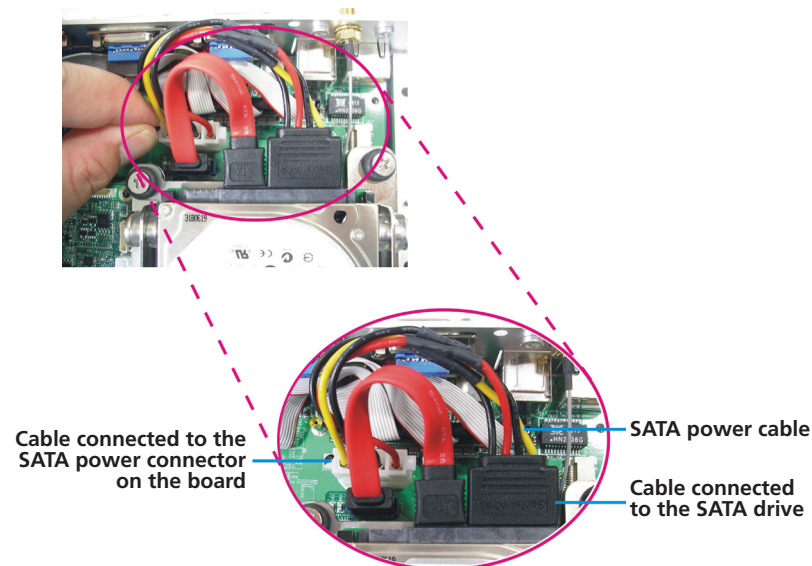
Power connector

SATA connector

7. Connect one end of the SATA data cable to the SATA connector that is on the board then connect the other end of the cable to the SATA connector at the rear of the SATA drive.

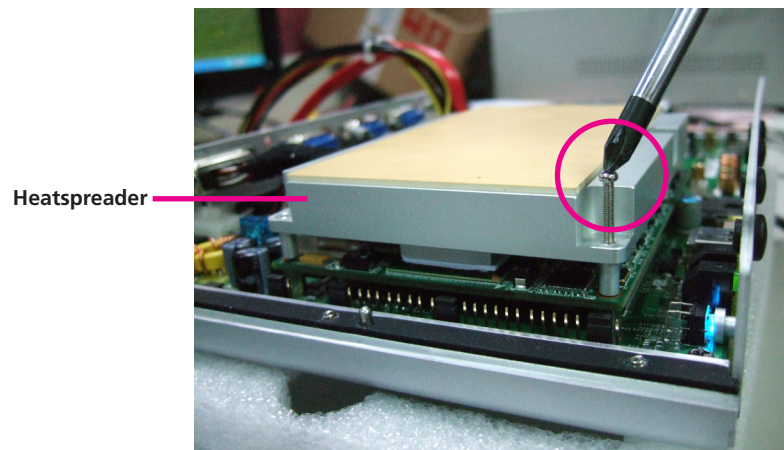


8. Connect one end of the SATA power cable to the SATA power connector that is on the board then connect the other end of the cable to the SATA power connector at the rear of the SATA drive.

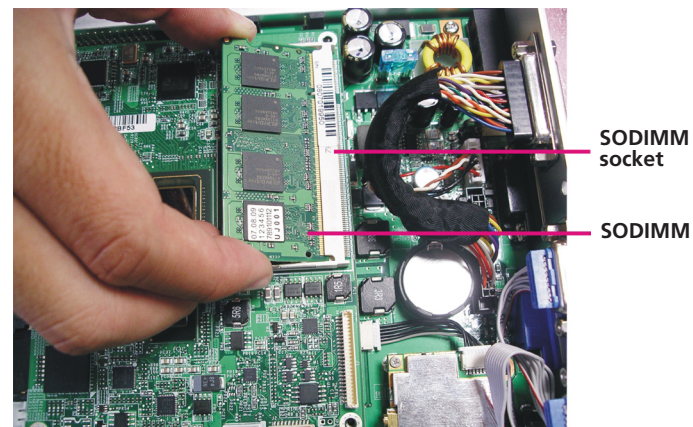


Installing the SODIMM

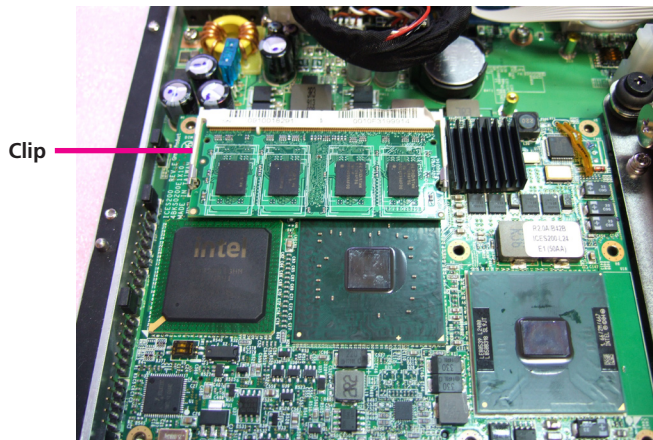
1. Remove the heatspreader's mounting screws.



2. Insert the module into the socket at an approximately 30 degrees angle. Apply firm even pressure to each end of the module until it slips into the socket. The gold-plated connector on the edge of the module will almost completely disappear inside the socket.



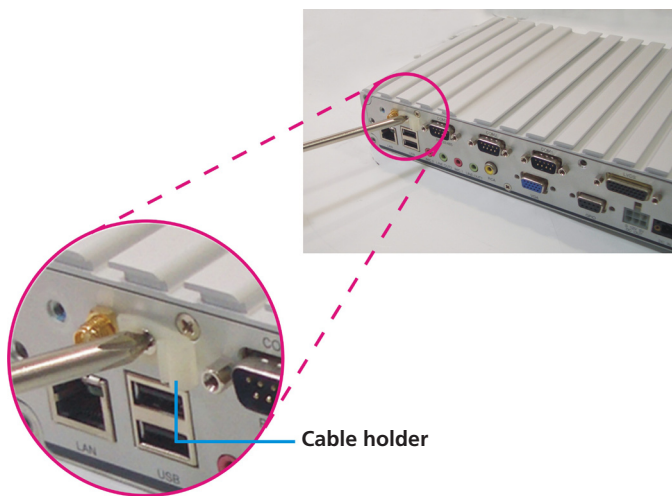
3. Push the module down until the clips on both sides of the socket lock into position. You will hear a distinctive “click”, indicating the module is correctly locked into position.



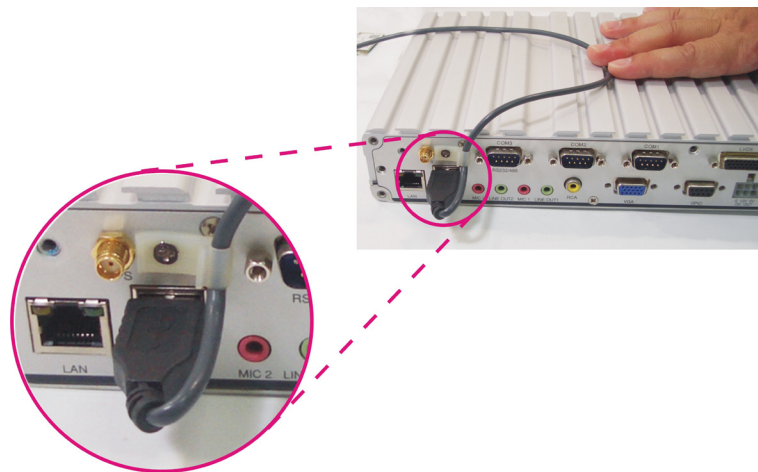
Installing the USB Cable Holder

The USB cable holder is used to stabilize the USB cable so as to prevent it from getting loose when accidentally pulled or moved.

1. Attach the cable holder to the mounting hole by using the provided screw.



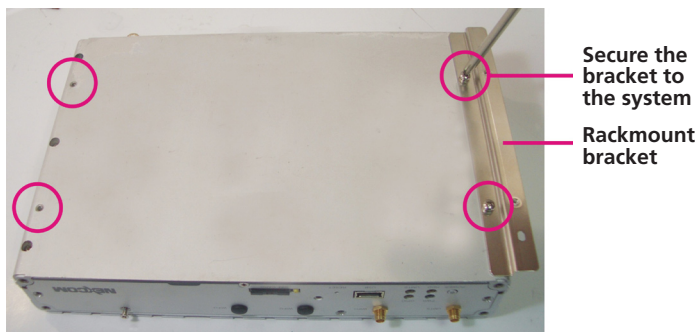
2. Hook the cable to the holder as shown in the photo below.



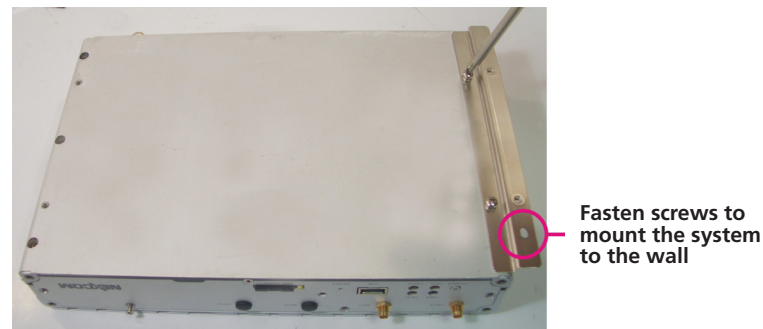
Rackmount Brackets

The rackmount brackets provide a convenient and economical way of mounting the system on the wall.

1. The mounting holes are located at the bottom of the system. Secure the brackets on each side of the system using the provided mounting screws.



2. Now mount the system on the wall by fastening screws through the bracket's mounting holes.



APPENDIX A: I/O ADDRESS FUNCTION

GPIO LED / UMTS LED / Ignition Status

I/O port : 0EE0H

Bit	Function Description
Bit 0	GPIO LED 0: OFF (default) 1: ON
Bit 1	UMTS LED 0: LED for WLAN (default) 1: LED for 3.5G and WLAN
Bit 2	Ignition (read only) 0: OFF 1: ON
Bit 3	Status of Vehicle Battery 0: Vehicle Battery is OK 1: Vehicle Battery is Low Voltage

Capacity of NEXCOM battery (8 bits)

I/O port : 0EE1H

	Bit0	Bit1	Bit2	Bit3	Bit4	Bit5	Bit6	Bit7
Description	8 bits data (Bit 7 is highest bit of data)							

Voltage of NEXCOM battery (8 bits)

I/O port : 0EE2H

	Bit0	Bit1	Bit2	Bit3	Bit4	Bit5	Bit6	Bit7
Description	8 bits data (Bit 7 is highest bit of data)							

Status of NEXCOM battery (8 bits)**I/O port : 0EE3H**

Bit	Function Description
Bit 0	Status for G sensor detection 0: Normal 1: Abnormal (X-axis or Y-axis degree is about 90 or -90)
Bit 1	Power mode 0: 24V system 1: 12V system
Bit 2	Fan mode 0: Auto 1: Always on
Bit 3	Status of Smart battery 0: No discharging 1: Discharging
Bit 4	Status of Fan R 0: Well 1: Failed
Bit 5	Status of Fan R 0: Action 1: Inaction
Bit 6	Status of Fan L 0: Well 1: Failed
Bit 7	Status of Fan L 0: Action 1: Inaction

GPIO**I/O port : 0EE4H**

Bit	Function Description
Bit 0-3	GPO 1-4
Bit 4-7	GPI 1-4

WDT**I/O port : 0EE5H**

Bit	Function Description
Bit 3	WDT Disable/Enable 0: Disable (default) 1: Enable

Bit 2, 1, 0: Time Setting

Bit 2~0	Time (sec)
000	1 (default)
001	2
010	4
011	8
100	16
101	32
110	64
111	128

Auto clear WDT timer when reading/writing I/O port 0EE5H.

Onboard Module Disable/Enable**I/O port : 0EE6H**

Bit	Function Description
Bit 0	3.5G module 0: Disable 1: Enable (default)
Bit 1	WLAN module 0: Disable 1: Enable (default)
Bit 2	External +12V power 0: Disable 1: Enable (default)
Bit 3	External +5V power 0: Disable 1: Enable (default)

APPENDIX B: ICES200-L24 COM EXPRESS CPU MODULE

Overview

ICES 200 is a Type 2 COM Express Module that features Intel® 945GME and ICH7M chipset; switch supports Intel® Core™ 2 Duo and Intel® Core™ 2 Duo LV processors with 533/667 MHz FSB. One DDR2 memory socket supports up to 2GB. The ICES 200 is integrated with Intel® Graphics Media Accelerator (GMA950) and expands via PCI Express Graphics x16 lanes to the carrier board. It also supports other display interfaces including LFP or Dual channel LVDS.

The high performance ICES 200 COM Express Module supports 2 x SATA, 8 x USB 2.0 and 4 PCIe x1 Lanes through the carrier board.

Key Features

- Intel® Socket M supports Core™ 2 Duo / Core™ 2 Duo LV Processor Family
- Intel® 945GME Chipset
- One DDR2 SO-DIMM socket supports un-buffered non-ECC DDR2 533/667 up to 2GB
- Supports 2 x Serial ATA for high speed drives, 8 x USB 2.0 for fast peripherals
- Type 2 COM Express Module supports up to 21 Express lanes, 32 bit PCI interface, one IDE and Gigabit LAN

Specifications

CPU Support

- Supports Intel® Socket M, Core™ 2 Duo Family Processors
- Supports 533/667MHz FSB CPU

Main Memory

- 1 x DDR2 SO-DIMM socket

Chipset

- Intel® 945GME
- ICH7M I/O Controller Hub

BIOS

- Award System BIOS
- Plug & Play support
- 8Mbit Flash ROM

Onboard LAN

- Realtek PCI Express GbE 8111C-GR
- Supports PXE LAN boot function
- Supports Wake on LAN

Display

- Integrated with Intel® Graphics Media Accelerator (GMA950) or expand via PCI Express Graphics x16 lanes / Dual SDVO
- CRT resolution up to 2048 x 1536 @ 60Hz, 1600 x 1200 @ 85Hz
- One PCI Express x16 Lane down to the carrier board
- Supports LFP (Local Flat Panel) LVDS interface with resolution up to 1366 x 768
- Supports Single channel for 18 bit / Dual Channel for 18 bit

Audio

- HD audio interface

COM Express Connectors

- AB
 - VGA / LVDS / 8 x USB 2.0 / HD Audio / 2 x SATA / LAN / GPIO / LPC bus / 1 x PCIe x4 / 1 x PCIe x1 / 5 x PCIe x1 / SMBus (I2C) / SPI BIOS
- CD
 - PCIe x16 / IDE / PCI

System Monitor

- Derived from HW monitor
- Monitors 4 voltages, 2 temperatures and 1 fan speed
- 4 voltages (For +3.3 V, +5 V, +12 V, Vcore)
- 2 temperatures (CPU and one external Temperature Sensor)

Power Requirements

- + 12 V, + 5 VSB, + 3.3 V RTC

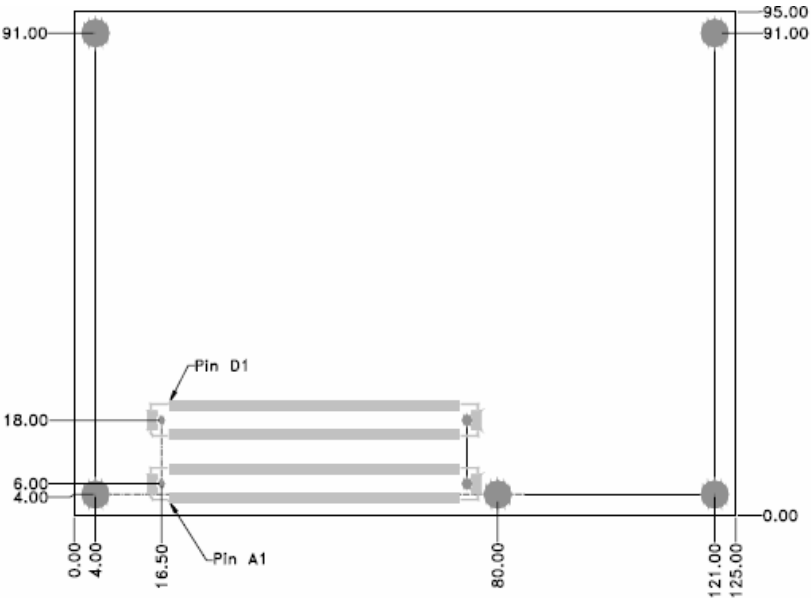


Dimensions

- COM Express Basic Module Type 2
- 95mm x 125mm



Mechanical Dimensions

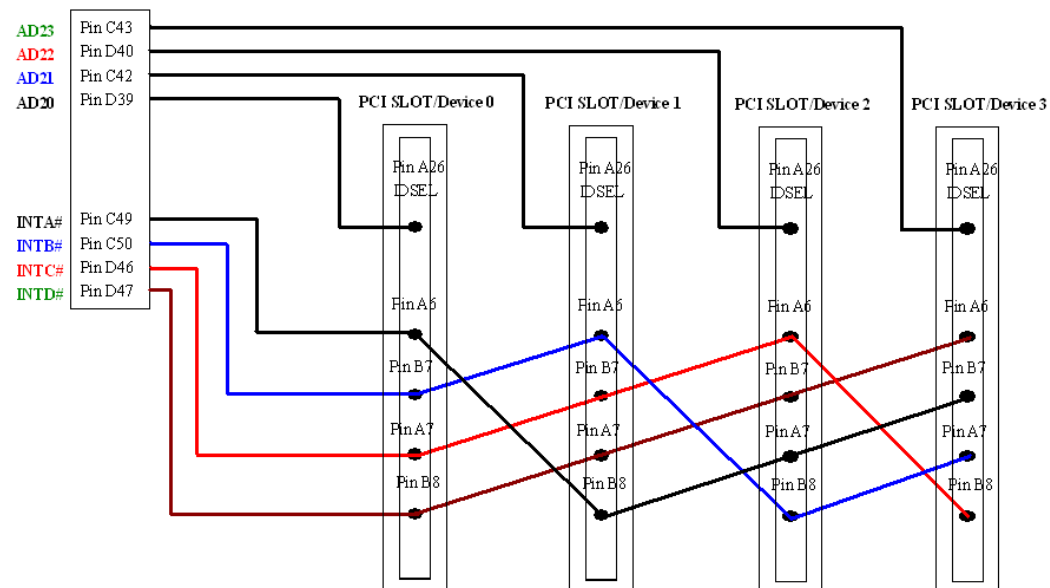


PCI Routing

Slot / Device Signal	Slot / Device 0	Slot / Device 1	Slot / Device 2	Slot / Device 3
IDSEL	AD20	AD21	AD22	AD23
INTA#	IRQA	IRQB	IRQC	IRQD
INTB#	IRQB	IRQC	IRQD	IRQA
INTC#	IRQC	IRQD	IRQA	IRQB
INTD#	IRQD	IRQA	IRQB	IRQC

COM Express Module Connector

COM Express Module Connector



Connectors

High Speed Board-to-Board Connector: COM Express Row A and Row B

Connector size: 2 X 110 = 220 Pins

Connector location: J2



Connector Pin Definition

Row A		Row B		Row A		Row B	
A1	GND	B1	GND	A56	PCIE_TX4-	B56	PCIE_RX4-
A2	GBE0_MDI3-	B2	GBE0_ACT#	A57	GND	B57	GPO2
A3	GBE0_MDI3+	B3	LPC_FRAME#	A58	PCIE_TX3+	B58	PCIE_RX3+
A4	GBE0_LINK100#	B4	LPC_AD0	A59	PCIE_TX3-	B59	PCIE_RX3-
A5	GBE0_LINK1000#	B5	LPC_AD1	A60	GND	B60	GND
A6	GBE0_MDI2-	B6	LPC_AD2	A61	PCIE_TX2+	B61	PCIE_RX2+
A7	GBE0_MDI2+	B7	LPC_AD3	A62	PCIE_TX2-	B62	PCIE_RX2-
A8	GBE0_LINK#	B8	LPC_DRQ0#	A63	GP1	B63	GPO3
A9	GBE0_MDI1-	B9	LPC_DRQ1#	A64	PCIE_TX1+	B64	PCIE_RX1+
A10	GBE0_MDI1+	B10	LPC_CLK	A65	PCIE_TX1-	B65	PCIE_RX1-
A11	GND	B11	GND	A66	GND	B66	WAKE0#
A12	GBE0_MDI0-	B12	PWRBTN#	A67	GP2	B67	WAKE1#

Row A		Row B		Row A		Row B	
A13	GBE0_MDIO+	B13	SMB_CK	A68	PCIE_TX0+	B68	PCIE_RX0+
A14	GBE0_CTREF	B14	SMB_DAT	A69	PCIE_TX0-	B69	PCIE_RX0-
A15	SUS_S3#	B15	SMB_ALERT#	A70	GND	B70	GND
A16	SATA0_TX+	B16	SATA1_TX+	A71	LVDS_A0+	B71	LVDS_B0+
A17	SATA0_TX-	B17	SATA1_TX-	A72	LVDS_A0-	B72	LVDS_B0-
A18	SUS_S4#	B18	SUS_STAT#	A73	LVDS_A1+	B73	LVDS_B1+
A19	SATA0_RX+	B19	SATA1_RX+	A74	LVDS_A1+	B74	LVDS_B1-
A20	SATA0_RX-	B20	SATA1_RX-	A75	LVDS_A2+	B75	LVDS_B2+
A21	GND	B21	GND	A76	LVDS_A2+	B76	LVDS_B2-
A22	NC	B22	NC	A77	LVDS_VDD_EN	B77	LVDS_B3+
A23	NC	B23	NC	A78	LVDS_A3+	B78	LVDS_B3-
A24	SUS_S5#	B24	PWR_OK	A79	LVDS_A3+	B79	LVDS_BKLT_EN
A25	NC	B25	NC	A80	GND	B80	GND
A26	NC	B26	NC	A81	LVDS_A_CK+	B81	LVDS_B_CK+
A27	BATLOW#	B27	NC	A82	LVDS_A_CK-	B82	LVDS_B_CK-
A28	ATA_ACT#	B28	AC_SDIN2	A83	LVDS_I2C_CK	B83	LVDS_BKLT_CTRL
A29	AC_SYNC	B29	AC_SDIN1	A84	LVDS_I2C_DAT	B84	VCC_5V_SBY
A30	AC_RST#	B30	AC_SDIN0	A85	GP13	B85	VCC_5V_SBY
A31	GND	B31	GND	A86	KBD_RST#	B86	VCC_5V_SBY
A32	AC_BITCLK	B32	SPKR	A87	KBD_A20GATE	B87	VCC_5V_SBY
A33	AC_SDOOUT	B33	I2C_CK	A88	PCIE0_CK_REF+	B88	RSVD
A34	BIOS_DISABLE#	B34	I2C_DAT	A89	PCIE0_CK_REF-	B89	VGA_RED
A35	THRMTRIP#	B35	THRM#	A90	GND	B90	GND
A36	USB6-	B36	USB7-	A91	RSVD	B91	VGA_GRN
A37	USB6+	B37	USB7+	A92	RSVD	B92	VGA_BLU
A38	USB_6_7_OC#	B38	USB_4_5_OC#	A93	GPO0	B93	VGA_HSYNC
A39	USB4-	B39	USB5-	A94	RSVD	B94	VGA_VSYNC

Row A		Row B		Row A		Row B	
A40	USB4+	B40	USB5+	A95	RSVD	B95	VGA_I2C_CK
A41	GND	B41	GND	A96	GND	B96	VGA_I2C_DAT
A42	USB2-	B42	USB3-	A97	VCC_12V	B97	NC
A43	USB2+	B43	USB3+	A98	VCC_12V	B98	NC
A44	USB_2_3_OC#	B44	USB_0_1_OC#	A99	VCC_12V	B99	NC
A45	USB0-	B45	USB1-	A100	GND	B100	GND
A46	USB0+	B46	USB1+	A101	VCC_12V	B101	VCC_12V
A47	VCC_RTC	B47	NC	A102	VCC_12V	B102	VCC_12V
A48	EXCD0_PERST#	B48	NC	A103	VCC_12V	B103	VCC_12V
A49	EXCD0_CPPE#	B49	SYS_RESET#	A104	VCC_12V	B104	VCC_12V
A50	LPC_SERIRQ	B50	CB_RESET#	A105	VCC_12V	B105	VCC_12V
A51	GND	B51	GND	A106	VCC_12V	B106	VCC_12V
A52	NC	B52	NC	A107	VCC_12V	B107	VCC_12V
A53	NC	B53	NC	A108	VCC_12V	B108	VCC_12V
A54	GPIO	B54	GPO1	A109	VCC_12V	B109	VCC_12V
A55	PCIE_TX4+	B55	PCIE_RX4+	A110	GND	B110	GND

High Speed Board-to-Board Connector:

COM Express Row C and Row D

Connector size: 2 X 110 = 220 Pins

Connector location: J1



Connector Pin Definition

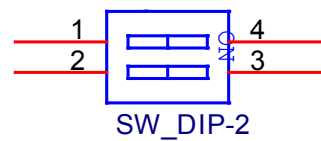
Row C		Row D		Row C		Row D	
C1	GND	D1	GND	C56	PEG_RX1-	D56	PEG_TX1-
C2	IDE_D7	D2	IDE_D5	C57	TYPE1#	D57	TYPE2#
C3	IDE_D6	D3	IDE_D10	C58	PEG_RX2+	D58	PEG_TX2+
C4	IDE_D3	D4	IDE_D11	C59	PEG_RX2-	D59	PEG_TX2-
C5	IDE_D15	D5	IDE_D12	C60	GND	D60	GND
C6	IDE_D8	D6	IDE_D4	C61	PEG_RX3+	D61	PEG_TX3+
C7	IDE_D9	D7	IDE_D0	C62	PEG_RX3-	D62	PEG_TX3-
C8	IDE_D2	D8	IDE_REQ	C63	RSVD	D63	RSVD
C9	IDE_D13	D9	IDE_IOW#	C64	RSVD	D64	RSVD
C10	IDE_D1	D10	IDE_ACK#	C65	PEG_RX4+	D65	PEG_TX4+
C11	GND	D11	GND	C66	PEG_RX4-	D66	PEG_TX4-
C12	IDE_D14	D12	IDE_IRQ	C67	RSVD	D67	GND

Row C		Row D		Row C		Row D	
C13	IDE_IORDY	D13	IDE_A0	C68	PEG_RX5+	D68	PEG_TX5+
C14	IDE_IOR#	D14	IDE_A1	C69	PEG_RX5-	D69	PEG_TX5-
C15	PCI_PME#	D15	IDE_A2	C70	GND	D70	GND
C16	PCI_GNT2#	D16	IDE_CS1#	C71	PEG_RX6+	D71	PEG_TX6+
C17	PCI_REQ2#	D17	IDE_CS3#	C72	PEG_RX6-	D72	PEG_TX6-
C18	PCI_GNT1#	D18	IDE_RESET#	C73	SDVO_DATA	D73	SDVO_CLK
C19	PCI_REQ1#	D19	PCI_GNT3#	C74	PEG_RX7+	D74	PEG_TX7+
C20	PCI_GNT0#	D20	PCI_REQ3#	C75	PEG_RX7-	D75	PEG_TX7-
C21	GND	D21	GND	C76	GND	D76	GND
C22	PCI_REQ0#	D22	PCI_AD1	C77	RSVD	D77	IDE_CBLID#
C23	PCI_RESET#	D23	PCI_AD3	C78	PEG_RX8+	D78	PEG_TX8+
C24	PCI_AD0	D24	PCI_AD5	C79	PEG_RX8-	D79	PEG_TX8-
C25	PCI_AD2	D25	PCI_AD7	C80	GND	D80	GND
C26	PCI_AD4	D26	PCI_C/BE0#	C81	PEG_RX9+	D81	PEG_TX9+
C27	PCI_AD6	D27	PCI_AD9	C82	PEG_RX9-	D82	PEG_TX9-
C28	PCI_AD8	D28	PCI_AD11	C83	RSVD	D83	RSVD
C29	PCI_AD10	D29	PCI_AD13	C84	GND	D84	GND
C30	PCI_AD12	D30	PCI_AD15	C85	PEG_RX10+	D85	PEG_TX10+
C31	GND	D31	GND	C86	PEG_RX10-	D86	PEG_TX10-
C32	PCI_AD14	D32	PCI_PAR	C87	GND	D87	GND
C33	PCI_C/BE1#	D33	PCI_SERR#	C88	PEG_RX11+	D88	PEG_TX11+
C34	PCI_PERR#	D34	PCI_STOP#	C89	PEG_RX11-	D89	PEG_TX11-
C35	PCI_LOCK#	D35	PCI_TRDY#	C90	GND	D90	GND
C36	PCI_DEVSEL#	D36	PCI_FRAME#	C91	PEG_RX12+	D91	PEG_TX12+
C37	PCI_IRDY#	D37	PCI_AD16	C92	PEG_RX12-	D92	PEG_TX12-
C38	PCI_C/BE2#	D38	PCI_AD18	C93	GND	D93	GND
C39	PCI_AD17	D39	PCI_AD20	C94	PEG_RX13+	D94	PEG_TX13+

Row C		Row D		Row C		Row D	
C40	PCI_AD19	D40	PCI_AD22	C95	PEG_RX13-	D95	PEG_TX13-
C41	GND	D41	GND	C96	GND	D96	GND
C42	PCI_AD21	D42	PCI_AD24	C97	RSVD	D97	PEG_ENABLE#
C43	PCI_AD23	D43	PCI_AD26	C98	PEG_RX14+	D98	PEG_TX14+
C44	PCI_C/BE3#	D44	PCI_AD28	C99	PEG_RX14-	D99	PEG_TX14-
C45	PCI_AD25	D45	PCI_AD30	C100	GND	D100	GND
C46	PCI_AD27	D46	PCI_IRQC#	C101	PEG_RX15+	D101	PEG_TX15+
C47	PCI_AD29	D47	PCI_IRQD#	C102	PEG_RX15-	D102	PEG_TX15-
C48	PCI_AD31	D48	PCI_CLKRUN#	C103	GND	D103	GND
C49	PCI_IRQA#	D49	PCI_M66EN	C104	VCC_12V	D104	VCC_12V
C50	PCI_IRQB#	D50	PCI_CLK	C105	VCC_12V	D105	VCC_12V
C51	GND	D51	GND	C106	VCC_12V	D106	VCC_12V
C52	PEG_RX0+	D52	PEG_TX0+	C107	VCC_12V	D107	VCC_12V
C53	PEG_RX0-	D53	PEG_TX0-	C108	VCC_12V	D108	VCC_12V
C54	TYPE0#	D54	PEG_LANE_RV#	C109	VCC_12V	D109	VCC_12V
C55	PEG_RX1+	D55	PEG_TX1+	C110	GND	D110	GND



PCIE 1X4 or PCIE 4X1 SWITCH



Pin	Status	Config
1 and 2	OFF	PCIE 4X1
1 and 2	ON	PCIE 1X4

APPENDIX C: VTCB6110 CARRIER BOARD

Specifications

Expansion

- 1 PCI-104 socket
- 1 Bluetooth module (optional)
- 2 Mini PCI Express socket
 - 1 PCIe interface for WLAN module
 - 1 PCIe + USB interface for 3.5G module

Storage

- One SATA 2.5" HDD bay
- One internal Type I/ II CompactFlash socket

I/O Interfaces - Front

- 4 SMA-type mounting holes for WLAN, HSDPA and Bluetooth
- 1 power button
- 1 reset switch
- 1 SIM card socket
- 1 USB 2.0
- 4 LEDs for Standby, HDD, WLAN/HSDPA and GPO
- 1 line-out
- 1 mic-in

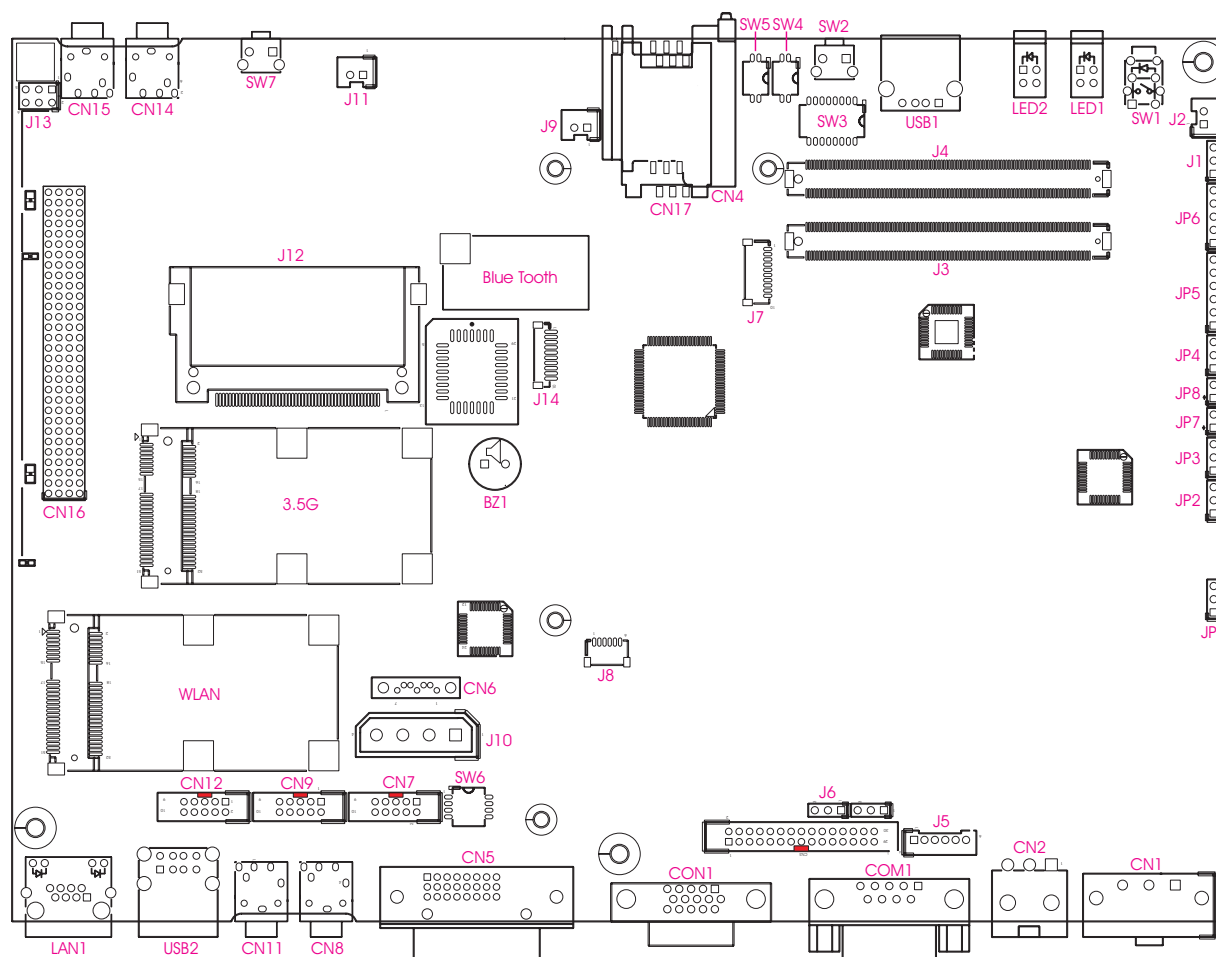
I/O Interfaces - Front

- 4 SMA-type mounting holes for WLAN, HSDPA and Bluetooth
- 1 power button
- 1 reset switch
- 1 SIM card socket
- 1 USB 2.0
- 4 LEDs for Standby, HDD, WLAN/HSDPA and GPO
- 1 line-out
- 1 mic-in

Dimensions

- 260mm(W) x 176mm(D) x 50mm(H)
10.24"(W) x 7"(D) x 1.97"(H)

Jumpers and Connectors



Jumper Settings

SW5: Input Voltage Selection

SW5 / Input Voltage	12V (default)	24V	6V~36V
SW5.1	OFF	OFF	ON
SW5.2	OFF	ON	Ignore

SW6: COM Port Mode Selection

SW6 COM Port Mode	RS232 (default)	RS485
SW6.1	OFF	ON
SW6.2	OFF	ON
SW6.3	OFF	ON

CF (IDE0) Primary Master/Slave Select (JP4)

Pin	Status	Function Description
1-2	Short	Slave
2-3 (default)	Short (default)	Master

LVDS Power Input Voltage Select (JP9)

Pin	Status	Function Description
1-2	Short	+5V IN
2-3 (default)	Short (default)	+3.3V IN

CMOS Input Voltage Select (J6)

Pin	Status	Function Description
1-2 (default)	Short (default)	VBAT IN
2-3	Short	Clear CMOS

BIOS Function Select (J1)

Pin	Status	Function Description
1-2	Short	Disable carrier board BIOS
2-3 (default)	Short (default)	Disable module board BIOS

DC Input Voltage Select (JP1)

Pin	Status	Function Description
1-2 (default)	Short (default)	IGNITION
2-3	Short	VIN_M

Temp Sensor (JP8)

Pin	Function Description
1	SENSOR+
2	GND

Auto Power Select (JP2)

Pin	Status	Function Description
1-2 (default)	Short (default)	AUTO
2-3	Short	BUTTON CONTROL

PCI-104 VI/O Select Voltage (J13)

Pin	Status	Function Description
1-4(*)	Short*	+3.3V
3-6	Short	+5V

MCU Download (JP6)

Pin	Function Description
1	+V3.3ALW
2	C2D
3	MRST
4	C2CK
5	GND

GAL Download (JP5)

Pin	Function Description
1	+V3.3S
2	GND
3	TCK
4	TDO
5	TDI
6	TMS

MCU COM Port (JP3)

Pin	Function Description
1	TX
2	RX
3	GND

Connectors

High Speed Board-to-Board Connector: COM Express Row A and Row B

Connector size: 2 x 110 = 220 pins

Connector location: J4



Connector Pin Definition

Row A		Row B		Row A		Row B	
A1	GND	B1	GND	A56	NC	B56	NC
A2	GBE0_MDI3-	B2	GBE0_ACT#	A57	GND	B57	NC
A3	GBE0_MDI3+	B3	LPC_FRAME#	A58	NC	B58	NC
A4	NC	B4	LPC_AD0	A59	NC	B59	NC
A5	NC	B5	LPC_AD1	A60	GND	B60	GND
A6	GBE0_MDI2-	B6	LPC_AD2	A61	NC	B61	NC
A7	GBE0_MDI2+	B7	LPC_AD3	A62	NC	B62	NC
A8	GBE0_LINK#	B8	NC	A63	GPI1	B63	GPO3
A9	GBE0_MDI1-	B9	NC	A64	NC	B64	NC
A10	GBE0_MDI1+	B10	LPC_CLK	A65	NC	B65	NC
A11	GND	B11	GND	A66	GND	B66	NC
A12	GBE0_MDI0-	B12	PWRBTN#	A67	NC	B67	NC

Row A		Row B		Row A		Row B	
A13	GBE0_MDIO+	B13	SMB_CK	A68	PCIE_TX0+	B68	PCIE_RX0+
A14	GBE0_CTREF	B14	SMB_DAT	A69	PCIE_TX0-	B69	PCIE_RX0-
A15	SUS_S3#	B15	SMB_ALERT#	A70	GND	B70	GND
A16	SATA0_TX+	B16	NC	A71	LVDS_A0+	B71	NC
A17	SATA0_TX-	B17	NC	A72	LVDS_A0-	B72	NC
A18	SUS_S4#	B18	SUS_STAT#	A73	LVDS_A1+	B73	NC
A19	SATA0_RX+	B19	NC	A74	LVDS_A1+	B74	NC
A20	SATA0_RX-	B20	NC	A75	LVDS_A2+	B75	NC
A21	GND	B21	GND	A76	LVDS_A2+	B76	NC
A22	NC	B22	NC	A77	LVDS_VDD_EN	B77	NC
A23	NC	B23	NC	A78	LVDS_A3+	B78	NC
A24	SUS_S5#	B24	PWR_OK	A79	LVDS_A3+	B79	LVDS_BKLT_EN
A25	NC	B25	NC	A80	GND	B80	GND
A26	NC	B26	NC	A81	LVDS_A_CK+	B81	NC
A27	BATLOW#	B27	NC	A82	LVDS_A_CK-	B82	NC
A28	ATA_ACT#	B28	NC	A83	LVDS_I2C_CK	B83	LVDS_BKLT_CTRL
A29	AC_SYNC	B29	NC	A84	LVDS_I2C_DAT	B84	VCC_5V_SBY
A30	AC_RST#	B30	AC_SDINO	A85	NC	B85	VCC_5V_SBY
A31	GND	B31	GND	A86	NC	B86	VCC_5V_SBY
A32	AC_BITCLK	B32	SPKR	A87	NC	B87	VCC_5V_SBY
A33	AC_SDOUT	B33	I2C_CK	A88	PCIE0_CK_REF+	B88	RSVD
A34	NC	B34	I2C_DAT	A89	PCIE0_CK_REF-	B89	NC
A35	NC	B35	THRM#	A90	GND	B90	GND
A36	USB6-	B36	NC	A91	RSVD	B91	NC
A37	USB6+	B37	NC	A92	RSVD	B92	NC
A38	USB_6_7_OC#	B38	USB_4_5_OC#	A93	NC	B93	NC
A39	USB4-	B39	USB5-	A94	RSVD	B94	NC

Row A		Row B		Row A		Row B	
A40	USB4+	B40	USB5+	A95	RSVD	B95	NC
A41	GND	B41	GND	A96	GND	B96	NC
A42	USB2-	B42	USB3-	A97	VCC_12V	B97	NC
A43	USB2+	B43	USB3+	A98	VCC_12V	B98	NC
A44	USB_2_3_OC#	B44	USB_0_1_OC#	A99	VCC_12V	B99	NC
A45	USB0-	B45	USB1-	A100	GND	B100	GND
A46	USB0+	B46	USB1+	A101	VCC_12V	B101	VCC_12V
A47	VCC_RTC	B47	NC	A102	VCC_12V	B102	VCC_12V
A48	NC	B48	NC	A103	VCC_12V	B103	VCC_12V
A49	NC	B49	SYS_RESET#	A104	VCC_12V	B104	VCC_12V
A50	NC	B50	CB_RESET#	A105	VCC_12V	B105	VCC_12V
A51	GND	B51	GND	A106	VCC_12V	B106	VCC_12V
A52	NC	B52	NC	A107	VCC_12V	B107	VCC_12V
A53	NC	B53	NC	A108	VCC_12V	B108	VCC_12V
A54	NC	B54	NC	A109	VCC_12V	B109	VCC_12V
A55	NC	B55	NC	A110	GND	B110	GND

High Speed Board-to-Board Connector: COM Express Row C and Row D

Connector size: 2 X 110 = 220 Pins

Connector location: J3



Connector Pin Definition

Row C		Row D		Row C		Row D	
C1	GND	D1	GND	C56	NC	D56	SDVOB_GREEN-
C2	IDE_D7	D2	IDE_D5	C57	NC	D57	NC
C3	IDE_D6	D3	IDE_D10	C58	NC	D58	SDVOB_BLUE+
C4	IDE_D3	D4	IDE_D11	C59	NC	D59	SDVOB_BLUE-
C5	IDE_D15	D5	IDE_D12	C60	GND	D60	GND
C6	IDE_D8	D6	IDE_D4	C61	NC	D61	SDVO_CLK+
C7	IDE_D9	D7	IDE_D0	C62	NC	D62	SDVO_CLK-
C8	IDE_D2	D8	IDE_REQ	C63	NC	D63	NC
C9	IDE_D13	D9	IDE_IOW#	C64	NC	D64	NC
C10	IDE_D1	D10	IDE_ACK#	C65	NC	D65	NC
C11	GND	D11	GND	C66	NC	D66	NC
C12	IDE_D14	D12	IDE_IRQ	C67	NC	D67	GND

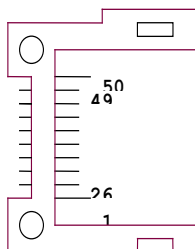
Row C		Row D		Row C		Row D	
C13	IDE_JORDY	D13	IDE_A0	C68	NC	D68	NC
C14	IDE_IOR#	D14	IDE_A1	C69	NC	D69	NC
C15	NC	D15	IDE_A2	C70	GND	D70	GND
C16	NC	D16	IDE_CS1#	C71	NC	D71	NC
C17	NC	D17	IDE_CS3#	C72	NC	D72	NC
C18	NC	D18	IDE_RESET#	C73	NC	D73	SDVO_CLK
C19	NC	D19	NC	C74	NC	D74	NC
C20	PCI_GNT0#	D20	NC	C75	NC	D75	NC
C21	GND	D21	GND	C76	GND	D76	GND
C22	PCI_REQ0#	D22	PCI_AD1	C77	NC	D77	IDE_CBLID#
C23	PCI_RESET#	D23	PCI_AD3	C78	NC	D78	NC
C24	PCI_AD0	D24	PCI_AD5	C79	NC	D79	NC
C25	PCI_AD2	D25	PCI_AD7	C80	GND	D80	GND
C26	PCI_AD4	D26	PCI_C/BE0#	C81	NC	D81	NC
C27	PCI_AD6	D27	PCI_AD9	C82	NC	D82	NC
C28	PCI_AD8	D28	PCI_AD11	C83	NC	D83	NC
C29	PCI_AD10	D29	PCI_AD13	C84	GND	D84	GND
C30	PCI_AD12	D30	PCI_AD15	C85	NC	D85	NC
C31	GND	D31	GND	C86	NC	D86	NC
C32	PCI_AD14	D32	PCI_PAR	C87	GND	D87	GND
C33	PCI_C/BE1#	D33	PCI_SERR#	C88	NC	D88	NC
C34	PCI_PERR#	D34	PCI_STOP#	C89	NC	D89	NC
C35	PCI_LOCK#	D35	PCI_TRDY#	C90	GND	D90	GND
C36	PCI_DEVSEL#	D36	PCI_FRAME#	C91	NC	D91	NC
C37	PCI_IRDY#	D37	PCI_AD16	C92	NC	D92	NC
C38	PCI_C/BE2#	D38	PCI_AD18	C93	GND	D93	GND
C39	PCI_AD17	D39	PCI_AD20	C94	NC	D94	NC

Row C		Row D		Row C		Row D	
C40	PCI_AD19	D40	PCI_AD22	C95	PEG_RX13-	D95	PEG_TX13-
C41	GND	D41	GND	C96	GND	D96	GND
C42	PCI_AD21	D42	PCI_AD24	C97	RSVD	D97	PEG_ENABLE#
C43	PCI_AD23	D43	PCI_AD26	C98	PEG_RX14+	D98	PEG_TX14+
C44	PCI_C/BE3#	D44	PCI_AD28	C99	PEG_RX14-	D99	PEG_TX14-
C45	PCI_AD25	D45	PCI_AD30	C100	GND	D100	GND
C46	PCI_AD27	D46	PCI_IRQC#	C101	PEG_RX15+	D101	PEG_TX15+
C47	PCI_AD29	D47	PCI_IRQD#	C102	PEG_RX15-	D102	PEG_TX15-
C48	PCI_AD31	D48	PCI_CLKRUN#	C103	GND	D103	GND
C49	PCI_IRQA#	D49	PCI_M66EN	C104	VCC_12V	D104	VCC_12V
C50	PCI_IRQB#	D50	PCI_CLK	C105	VCC_12V	D105	VCC_12V
C51	GND	D51	GND	C106	VCC_12V	D106	VCC_12V
C52	PEG_RX0+	D52	PEG_TX0+	C107	VCC_12V	D107	VCC_12V
C53	PEG_RX0-	D53	PEG_TX0-	C108	VCC_12V	D108	VCC_12V
C54	TYPE0#	D54	PEG_LANE_RV#	C109	VCC_12V	D109	VCC_12V
C55	PEG_RX1+	D55	PEG_TX1+	C110	GND	D110	GND

CompactFlash Connector

Connector size: 2 x 25 = 50 pins

Connector location: J12



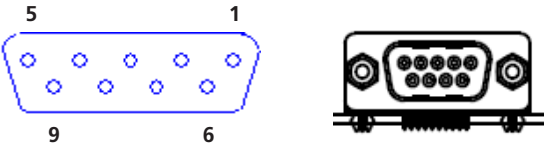
Connector Pin Definition

Pin	Description	Pin	Description
1	Gnd	2	Data 3
3	Data 4	4	Data 5
5	Data 6	6	Data 7
7	HDC CS100	8	Gnd
9	Gnd	10	Gnd
11	Gnd	12	Gnd
13	+5V	14	Gnd
15	Gnd	16	Gnd
17	Gnd	18	Disk Address 2
19	Disk Address 1	20	Disk Address 0
21	Data 0	22	Data 1

Pin	Description	Pin	Description
23	Data 2	24	IOCS16# (NC)
25	CF_CD2# (Pull-down)	26	CF_CD1# (Pull-down)
27	Data 11	28	Data 12
29	Data 13	30	Data 14
31	Data 15	32	HDC CS300
33	CF_VS1# (NC)	34	IOR
35	IOW	36	CF_WE# (+5V)
37	Interrupt 15	38	+5V
39	CF_CSEL# (Master or Slave)	40	CF_VS2# (NC)
41	Reset #	42	IOCHRDY
43	DMA REQ / DACK (NC)	44	DMA ACK# /CF_REG# (+5V)
45	HDD Active Led	46	DMA66 Detect / CF_PDIAG#
47	Data 8	48	Data 9
49	Data 10	50	Gnd

GPIO Connector

Connector size: DSUB-9 pin
Connector location: COM1

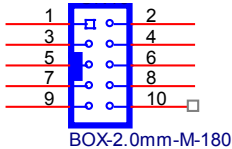


Connector Pin Definition

Pin	Description	Pin	Description
1	GIN1	2	GIN2
3	GIN3	4	GIN4
5	GOUT4	6	GOUT1
7	GOUT2	8	GOUT3
9	GND		

RS232 Connector: COM1, COM2

Connector size: 2 x 10 = 20 Pins Pin Header, (2.0 mm Pitch)
Connector location: COM1 (CN9), COM2 (CN7)

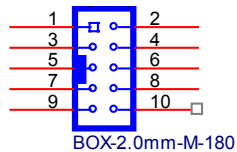


Connector Pin Definition

Pin	Definition	Pin	Definition
1	DCD	2	RXD
3	TXD	4	DTR
5	Gnd	6	DSR
7	RTS	8	CTS
9	RI		

RS232/485 Connector: COM3

Connector size: 2 x 10 = 20 Pins Pin Header, (2.0 mm Pitch)
Connector location: CN12

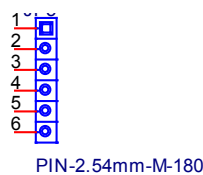


Connector Pin Definition

Pin	Definition	Pin	Definition
1	DCD (RS232) TX-/RX- (RS485)	2	RXD (RS232) TX+/RX+ (RS485)
3	TXD (RS232)	4	DTR (RS232)
5	Gnd	6	DSR (RS232)
7	RTS (RS232)	8	CTS (RS232)
9	RI (RS232)		

GAL Programmer PIN Header

Connector size: 2.54mm-M-180
Connector location: JP5

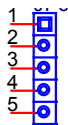


Connector Pin Definition

Pin	Definition	Pin	Definition
1	+3.3V	2	GND
3	TCK	4	TDO
5	TDI	6	TMS

MCU Programmer Pin Header

Connector size: 2.54mm-M-180
Connector location: JP6



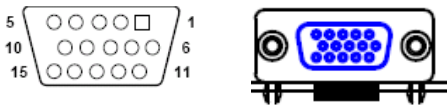
PIN-2.54mm-M-180

Connector Pin Definition

Pin	Definition	Pin	Definition
1	+3.3ALW	2	C2D
3	MRST	4	C2CK
5	GND		

VGA Connector

Connector size: DSUB-15
Connector location: CON1



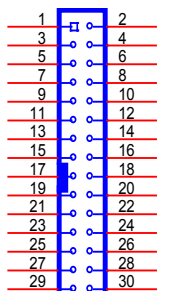
Connector Pin Definition

Pin	Definition	Pin	Definition
1	RED	2	GREEN
3	BLUE	4	NC
5	Gnd	6	Gnd
7	Gnd	8	Gnd
9	VCC	10	Gnd
11	NC	12	DDCDAT
13	Hsync	14	Vsync
15	DDCCLK		

LVDS Connector + USB0

Connector size: 2 x 15 (2.0mm)

Connector location: CN3



BOX-2.0mm-M-180

Connector Pin Definition

Pin	Definition	Pin	Definition
1	LVDS_CLK	2	LVDS_DAT
3	Panel_VDD	4	LVDS_1(OUT0)
5	LVDS_9(OUT3)	6	LVDS_0(OUT0#)
7	LVDS_8(OUT3#)	8	Panel_VDD
9	LVDS_GND	10	LVDS_GND
11	LVDS_7(CLK)	12	LVDS_3(OUT1)
13	LVDS_6(CLK#)	14	LVDS_2(OUT1#)
15	LVDS_GND	16	LVDS_GND

Pin	Definition	Pin	Definition
17	LVDS_5(OUT2)	18	Panel_backlight(+12V)
19	LVDS_4(OUT2#)	20	Panel_backlight(+12V)
21	LVDS_GND	22	Power on push button
23	USB_0#	24	USB_GND
25	USB_0	26	USB_VCC (+5V)
27	USB_GND	28	USB_GND
29	Panel_backlight(+12V)	30	GND

LAN Connector

Connector size: RJ-45
Connector location: LAN1



Connector Pin Definition

Pin	Definition	Pin	Definition
1	TX+	2	TX-
3	RX+	4	N/C1
5	N/C2	6	RX-
7	N/C3	8	N/C4
9	LAN Speed LED	10	+3.3V
11	LAN Link LED	12	+3.3V

USB Connector

Connector location: USB1



Connector Pin Definition

Pin	Definition	Pin	Definition
1	VCC	2	DATA-
3	DATA+	4	GND

USB Connector

Connector location: USB2



Connector Pin Definition

Pin	Definition	Pin	Definition
1	VCC	2	DATA1-
3	DATA1+	4	GND
5	VCC	6	DATA-
7	DATA+	8	GND

LVDS Power Connector

Connector location: J5

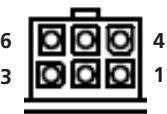


Connector Pin Definition

Pin	Definition	Pin	Definition
1	Panel_backlight	2	Panel_VDD
3	GND	4	GND
5	LVDS_PANEL	6	LVDS_BIASON

External 12V & 5V Power and SMBUS Connector

Connector location: CN2



Connector Pin Definition

Pin	Definition	Pin	Definition
1	5V	2	12V
3	SMBCLK	4	GND
5	GND	6	SMBDATA

Mic-in

Connector location: CN11 and CN15



Connector Pin Definition

Pin	Definition	Pin	Definition
1	NC	2	MIC_JD
3	NC	4	MIC_OUT
5	GND	6	GND

Line-out

Connector location: CN8 and CN14

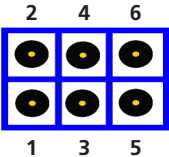


Connector Pin Definition

Pin	Definition	Pin	Definition
1	LINE_OUT_L	2	SURR_JD
3	NC	4	LINE_OUT_R
5	GND	6	GND

PCI-104 VI/O Voltage Setting

Connector location: J13

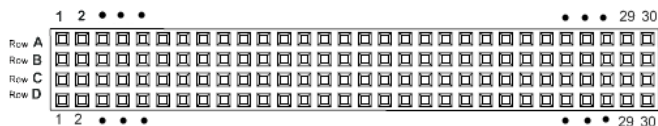


Connector Pin Definition

Pin No.	Status	Function Description
1-3, 2-4 (default)	Short	+3.3V
3-5, 4-6	Short	+5V

PCI-104 Connector

Connector location: CN16

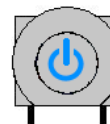


Connector Pin Definition

Pin	A	B	C	D
1	GND	Reserved	+5	AD00
2	VI/O	AD02	AD01	+5V
3	AD05	GND	AD04	AD03
4	C/BE0#	AD07	GND	AD06
5	GND	AD09	AD08	GND
6	AD11	VI/O	AD10	M66EN
7	AD14	AD13	GND	AD12
8	+3.3V	C/BE1#	AD15	+3.3V
9	SERR#	GND	Reserved	PAR
10	GND	PERR#	+3.3V	Reserved
11	STOP#	+3.3V	LOCK#	GND
12	+3.3V	TRDY#	GND	DEVSEL#
13	FRAME#	GND	IRDY#	+3.3V
14	GND	AD16	+3.3V	C/BE2#
15	AD18	+3.3V	AD17	GND
16	AD21	AD20	GND	AD19
17	+3.3V	AD23	AD22	+3.3V
18	IDSEL0	GND	IDSEL1	IDSEL2
19	AD24	C/BE3#	VI/O	IDSEL3
20	GND	AD26	AD25	GND
21	AD29	+5V	AD28	AD27
22	+5V	AD30	GND	AD31
23	REQ0#	GND	REQ1#	VI/O
24	GND	REQ2#	+5V	GNT0#
25	GNT1#	VI/O	GNT2#	GND
26	+5V	CLK0	GND	CLK1
27	CLK2	+5V	CLK3	GND
28	GND	INTD#	+5V	RST#
29	+12V	INTA#	INTB#	INTC#
30	-12V	REQ3#	GNT3#	GND

Power Button

Connector location: SW1



Reset Button

Connector location: SW2





MCU COM Port

Connector location: JP3

Connector Pin Definition

Pin	Function Description
1	TX
2	RX
3	GND

ACC_ON LED

Connector location: JP7



Connector Pin Definition

Pin	Function Description
1	+3.3V LED
2	GND

Temp Sensor

Connector location: JP8



Connector Pin Definition

Pin	Function Description
1	SENSOR+
2	GND

DC Power Input Connector

Connector location: CN1



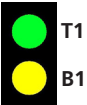
Connector Pin Definition

Pin	Function Description
1	GND
2	VIN (6V~36V)
3	IGNITION



Power On and IDE Active LED

Connector location: LED1



Connector Pin Definition

LED	Function Description
T1	POWER LED
B1	HD LED

GPIO and UMTS LEDs

Connector location: LED2



LED I/O Port Address and Data

LED	Function Description
T2	I/O PORT Address: 0EE0; Bit0: 1 (Light), 0 (Dark)
B2	UMTS STATUS

Serial ATA

Connector location: CN6



Connector Pin Definition

Pin	Definition	Pin	Definition
1	GND	2	SATA_TXP0 -
3	SATA_TXN0	4	GND
5	SATA_RXN0	6	SATA_RXP0
7	GND		

Serial ATA Power Input

Connector location: J10

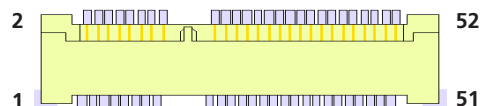


Connector Pin Definition

Pin	Definition	Pin	Definition
1	+V12S	2	GND
3	GND	4	+V5S

Mini-PCIe Socket (for 3.5G module) PCIe Interface

Connector location: CN10

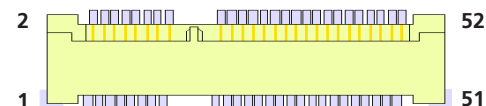


Connector Pin Definition

Pin	Definition	Pin	Definition	Pin	Definition	Pin	Definition
1	MIC +	2	+V3.3S	27	GND	28	NC
3	MIC -	4	GND	29	GND	30	NC
5	SPK +	6	NC	31	NC	32	NC
7	GND	8	USIM PWR	33	RESET	34	GND
9	GND	10	USIM DATA	35	GND	36	USB_D-
11	VCC_MSM26_DIG	12	USIM CLK	37	GND	38	USB_D+
13	NC	14	USIM RST	39	+V3.3S	40	GND
15	GND	16	NC	41	+V3.3S	42	LED_WWAN#
17	NC	18	GND	43	GND	44	NC
19	NC	20	W_DISABLE#	45	NC	46	NC
21	GND	22	NC	47	NC	48	NC
23	NC	24	NC	49	NC	50	GND
25	NC	26	GND	51	NC	52	+V3.3S

Mini-PCIe Socket (for WLAN module) USB + PCIe Interface

Connector location: CN13

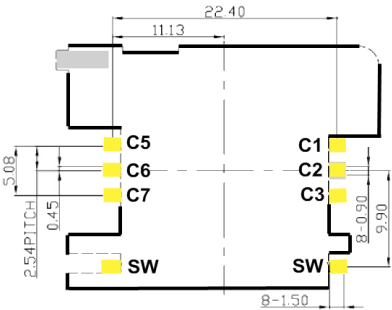


Connector Pin Definition

Pin	Definition	Pin	Definition	Pin	Definition	Pin	Definition
1	WAKE#	2	+V3.3S	27	GND	28	+V1.5S
3	NC	4	GND	29	GND	30	SMB_CLK
5	NC	6	+V1.5S	31	PETn0	32	SMB_DATA
7	CLKREQ#	8	NC	33	PETp0	34	GND
9	GND	10	NC	35	GND	36	USB_D-
11	REFCLK-	12	NC	37	NC	38	USB_D+
13	REFCLK+	14	NC	39	NC	40	GND
15	GND	16	NC	41	NC	42	LED_WWAN#
17	NC	18	GND	43	NC	44	LED_WLAN#
19	NC	20	DISABLE#	45	NC	46	LED_WPAN#
21	GND	22	PERST#	47	NC	48	+V1.5S
23	PERn0	24	+3.3S	49	NC	50	GND
25	PERp0	26	GND	51	NC	52	+V3.3S

SIM Card Connector

Connector location: CN4

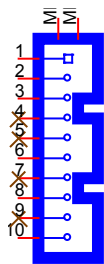


Connector Pin Definition

Pin	Definition	Pin	Definition
C1	POWER VOLTAGE	C2	RESET SIGNAL
C3	CLOCK SIGNAL	C5	GND
C6	VPP:PROGRAM VOLTAGE	C7	I/O
SW	Contact present switch		

Bluetooth Connector

Connector location: J7

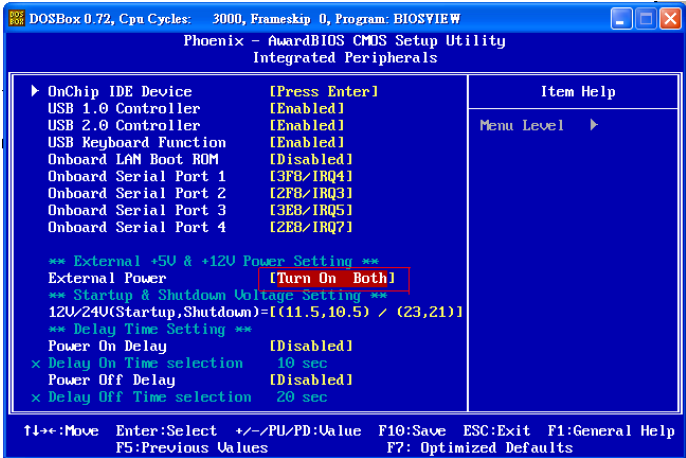


Pin	Definition	Pin	Definition
1	GND	2	USB_6P_L
3	USB_6N_L	4	NC
5	NC	6	BT_AUDIO_EN_R
7	NC	8	BT_3.3V
9	NC	10	GND

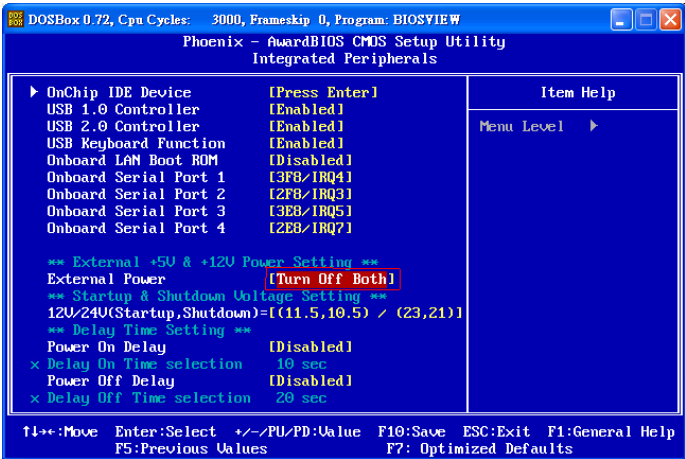
APPENDIX D: VEHICLE POWER MANAGEMENT SETUP

External Power Output Setting

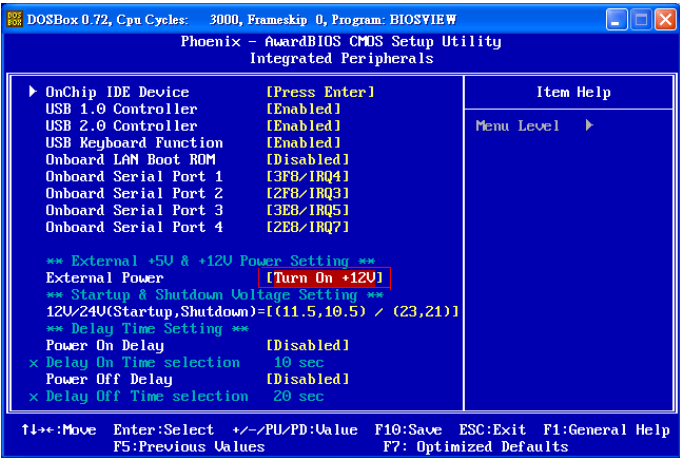
External +12V and +5V Turn On Simultaneously



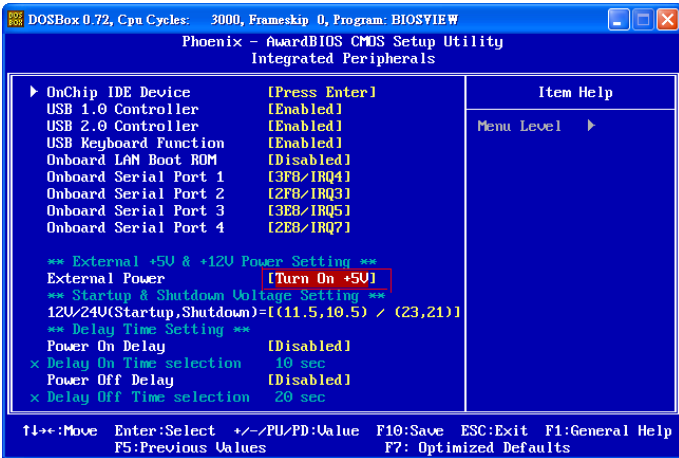
External +12V and +5V Turn Off Simultaneously



External +12V Turn On Only



External +5V Turn On Only



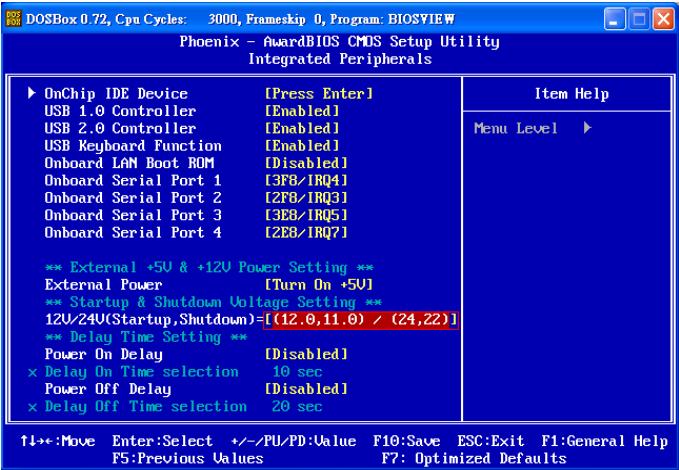
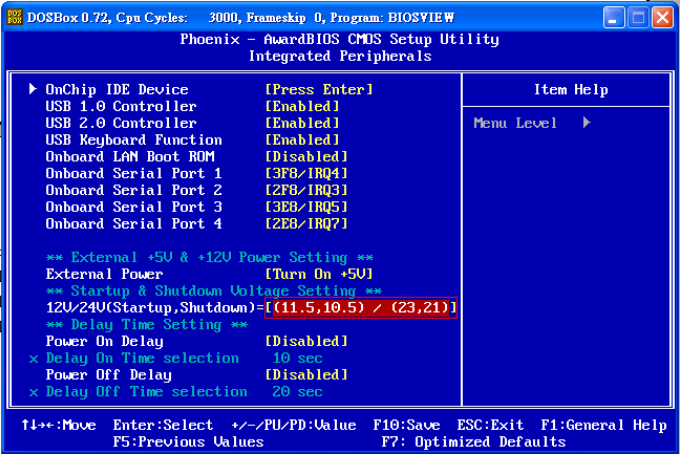
Startup and Shutdown Voltage Setting

1. If the input voltage setting is 12V: set the startup voltage to 11.5V and the shutdown voltage to 10.5V.
- If the input voltage setting is 24V: set the startup voltage to 23V and the shutdown voltage to 21V.
- If the input voltage setting is 6V~36V, ignore the startup/shutdown setting.

2. If the input voltage setting is 12V: set the startup voltage to 12V and the shutdown voltage to 11V.

If the input voltage setting is 24V: set the startup voltage to 24V and the shutdown voltage to 22V.

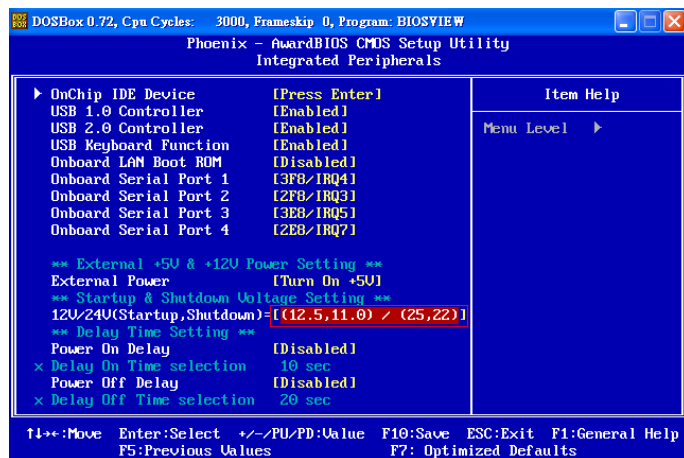
If the input voltage setting is 6V~36V, ignore the startup/shutdown setting.



3. If the input voltage setting is 12V: set the startup voltage to 12.5V and the shutdown voltage to 11V.

If the input voltage setting is 24V: set the startup voltage to 25V and the shutdown voltage to 22V.

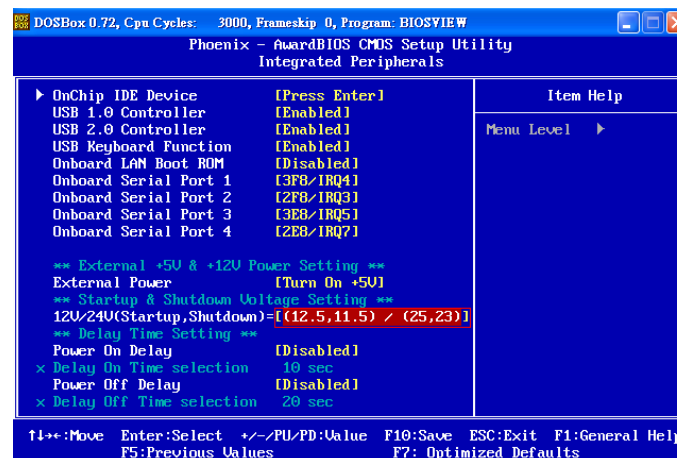
If the input voltage setting is 6V~36V, ignore the startup/shutdown setting.



4. If the input voltage setting is 12V: set the startup voltage to 12.5V and the shutdown voltage to 11.5V.

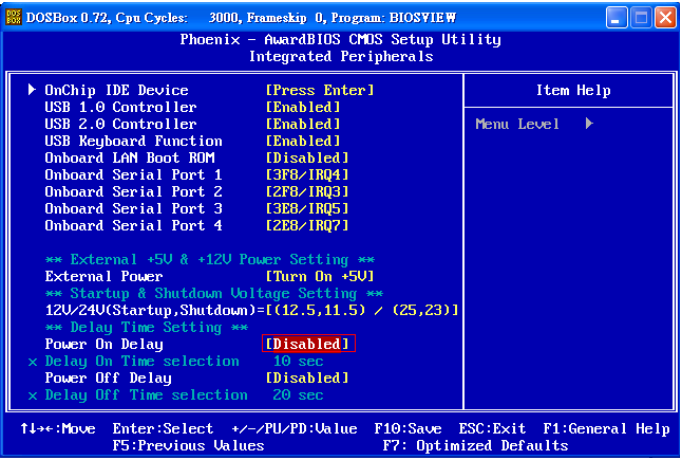
If input voltage setting is 24V: set the startup voltage to 25V and the shutdown voltage to 23V.

If the input voltage setting is 6V~36V ignore the startup/shutdown setting.



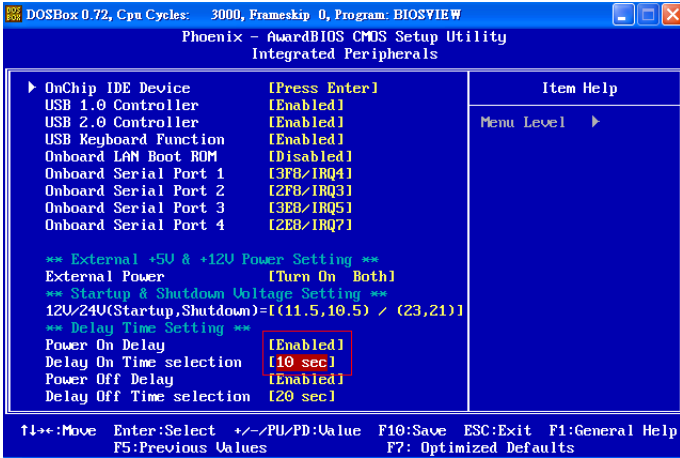
Power-on Delay Setting

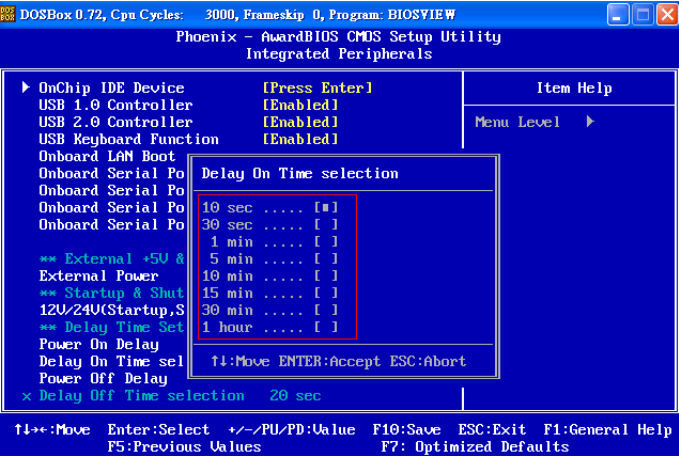
Disable Power-on Delay



Enable Power-on Delay

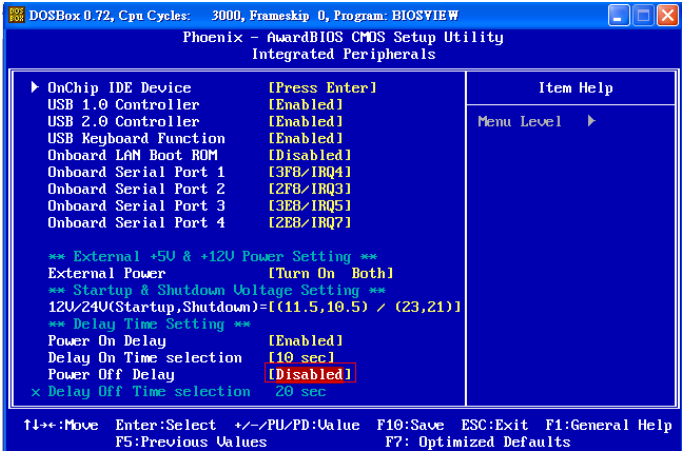
Delay time can be set at 10sec/30sec/1min./5min./10min./15min./30min./1 hour.





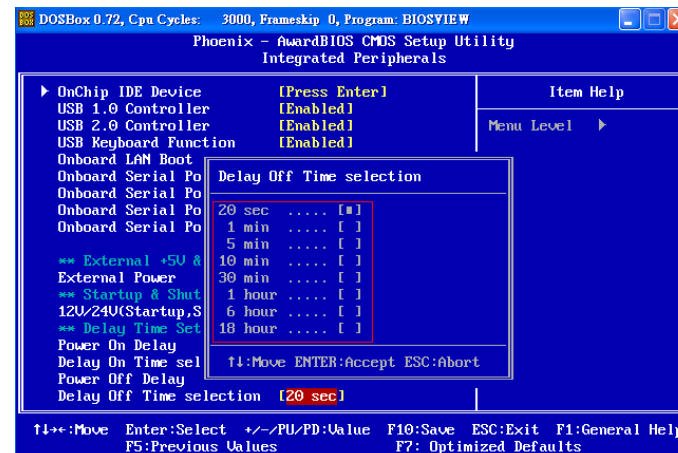
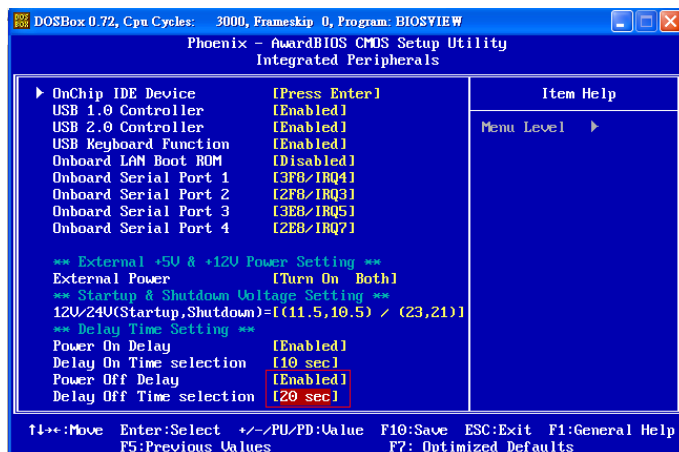
Power-off Delay Setting

Disable Power-off Delay



Enable Power-off Delay

Delay time can be set at 20sec/1min./5min./10min./30min./1hour/6hour/18hour.





APPENDIX E: POWER CONSUMPTION

OS: XP English
Burn-in Software: Version 5.0

Idle Mode	100% Burn-in Mode	S3	S4	S5
1.47A / 12V	2.76A / 12V	0.11A / 12V	0.01A /12V	0.01A /12V

* Device: N/A